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(54) **Titre : PROCÉDES ET SYSTÈMES DE SOUDAGE DE CUIVRE A L'AIDE DE LASER BLEU**
(54) **Title: METHODS AND SYSTEMS FOR WELDING COPPER USING BLUE LASER**

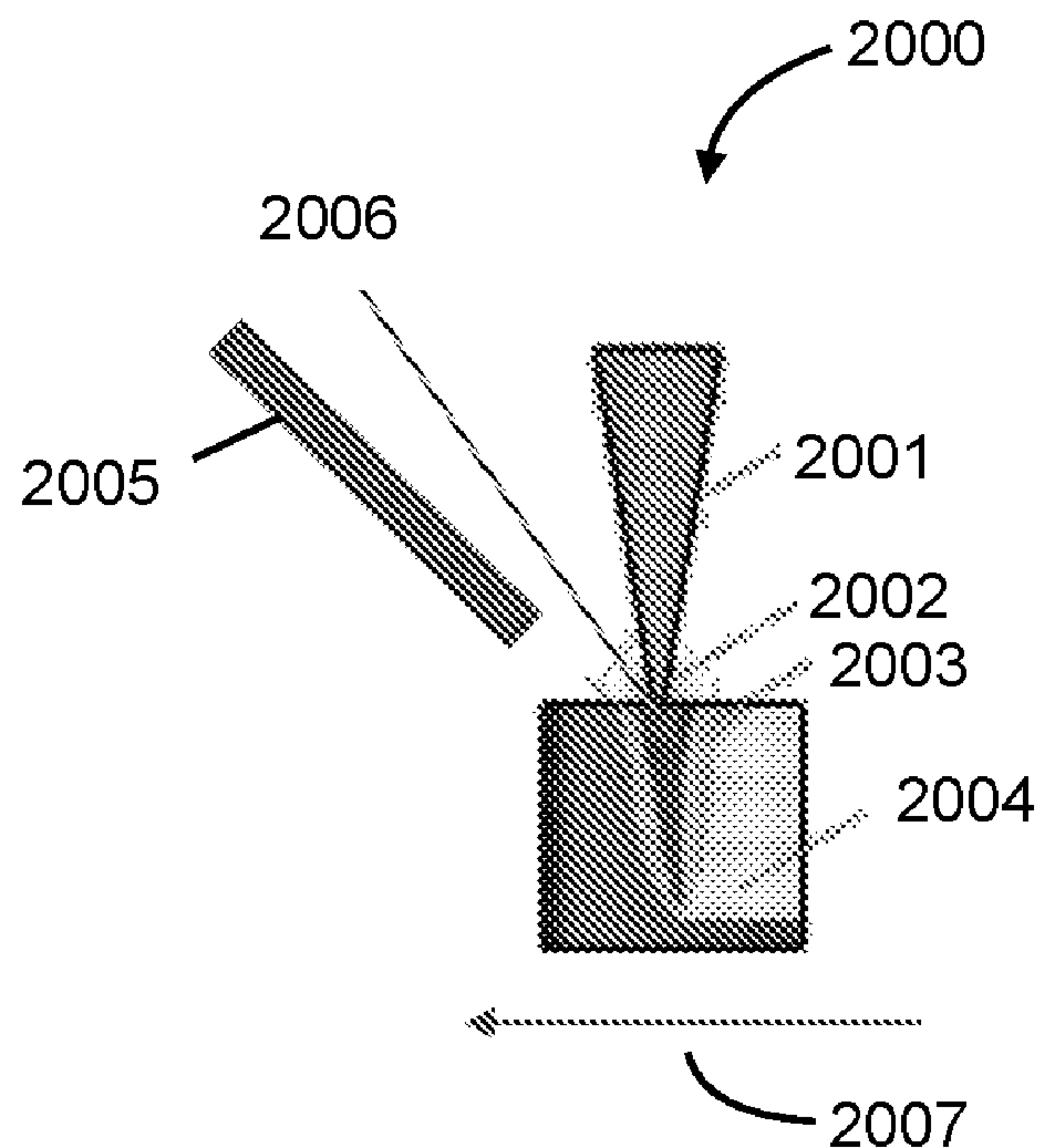


FIG. 11

(57) **Abrégé/Abstract:**

A visible light laser system and operation for welding materials together. A blue laser system that forms essentially perfect welds for copper based materials. A blue laser system and operation for welding conductive elements, and in particular thin conductive elements, together for use in energy storage devices, such as battery packs.

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(54) Title: METHODS AND SYSTEMS FOR WELDING COPPER USING BLUE LASER

(57) Abstract: A visible light laser system and operation for welding materials together. A blue laser system that forms essentially perfect welds for copper based materials. A blue laser system and operation for welding conductive elements, and in particular thin conductive elements, together for use in energy storage devices, such as battery packs.

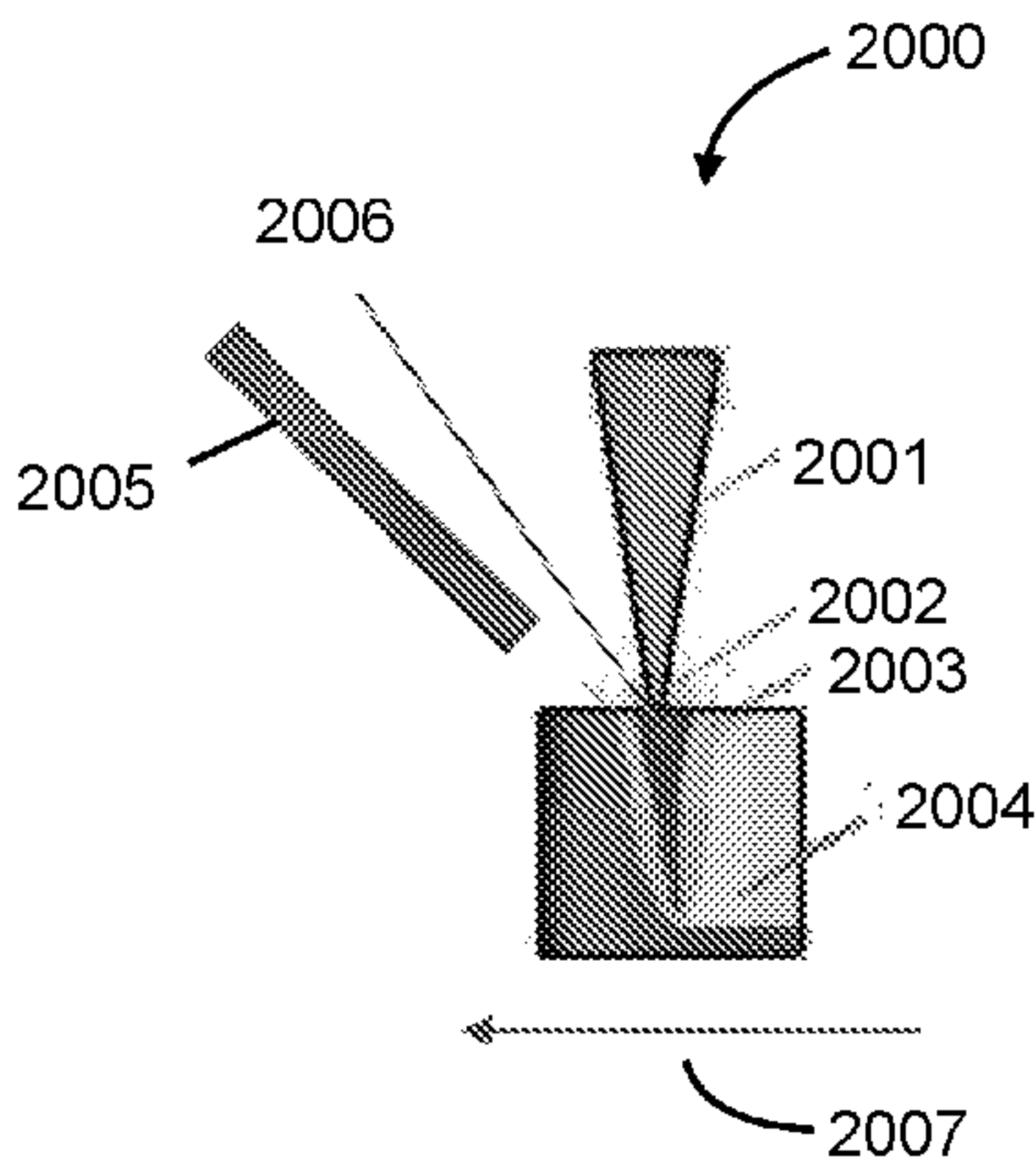


FIG. 11

WO 2018/144524 A1

Methods and Systems for Welding Copper Using Blue Laser

[0001] This application claims under 35 U.S.C. §119(e)(1) the benefit of the
5 filing date of US provisional application serial number 62/452,598 filed January 31,
2017, the entire disclosure of which is incorporated herein by reference.

BACKGROUND OF THE INVENTION

Field of the Invention

[0002] The present inventions relate to laser processing of materials, and in
10 particular laser joining of copper materials using laser beams having wavelengths from
about 350 nm to about 500 nm, and greater.

[0003] Laser welding of copper has proven to be very challenging due to high
reflectivity, high thermal conductivity and high heat capacity. Numerous methods have
been developed to weld copper ranging from ultrasonic welding to IR laser welding.
15 These prior copper welding methods, however, have many shortcomings and
limitations. For example, one market where these limitations are seen is in the area of
high performance electronics for the growing electronic vehicle market. A better weld
quality with higher speed, than can be obtained by these prior techniques, is needed to
produce high performance batteries and electronics for the growing automotive markets.

20 [0004] When using an IR laser source at 1030 nm, the high reflectivity of the
copper at this wavelength makes it difficult to couple power into the material to heat and
weld it. One method to overcome the high reflectivity is to use a high-power level (>
1kW) IR laser to initiate a keyhole weld which then couples the power into the material.
The problems with this method of welding, among other things, is that the vapor in the
25 keyhole can lead to a micro-explosion, spraying molten copper all over the parts being
welded or the micro-explosion can cause a hole completely through the parts being
welded. Consequently, researchers have had to rely on rapidly modulating the laser
power to try to prevent these defects during welding. It has been discovered that the
defects are a direct result of the process itself, as the laser attempts to weld the copper,
30 it initially heats it up to the melting point and then it rapidly transitions into vaporizing the
copper. Once the copper vaporizes the keyhole is formed and the laser coupling rises
rapidly from the initial 5% to 100%, this transition occurs so rapidly that the amount of

heat coupled in rapidly exceeds the amount of heat needed to weld the parts, resulting in the micro-explosion described.

[0005] Laser welding of copper with current infrared lasers method and systems is challenging, and has problems, due to the high reflectivity, high thermal conductivity, low vaporization points and high heat capacity. Numerous methods have been attempted to weld copper with IR lasers ranging from combining the IR laser with a green laser, wobbling the spot in the weld puddle, operating in a vacuum and modulating the laser at a high frequency. While these approaches are currently in use for some copper welding applications, they tend to have narrow processing windows, uncontrolled spatter, and unpredictable variability in the welds, and have generally proved to be less than desirable or optimal. One of the more difficult copper welding process is the how to weld stacks of copper foil to each other and to thicker bus bars. Today, this cannot be done with an IR laser reliably or in a manner that produces the weld qualities that are needed by manufactures. Thus, manufacturers have relied on ultrasonic welding methods to bond these foils together. These ultrasonic methods are also less than optimal and are problematic. For example, with ultrasonic welding methods, the sonotrodes can wear during production resulting in process variabilities ranging from incomplete welds to welds with debris left behind. These deficiencies limit the manufacturing yield, the internal resistance of batteries, the energy density of the resulting batteries and in many cases the reliability of the batteries.

[0006] The term “copper based material” unless expressly provided otherwise, should be given it broadest possible meaning and would include copper, copper materials, copper metal, materials electroplated with copper, metallic materials that contain from at least about 10% copper by weight to 100% copper, metals and alloys containing from at least about 10% copper by weight to 100% copper by weight, metals and alloys containing from at least about 20% copper by weight to 100% copper by weight, metals and alloys containing from at least about 10% copper by weight to 100% copper by weight, metals and alloys containing from at least about 50% copper by weight to 100% copper by weight, metals and alloys containing from at least about 70% copper by weight to 100% copper by weight, and metals and alloys containing from at least about 90% copper by weight to 100% copper by weight.

[0007] The terms “laser processing, “laser processing of materials,” and similar such terms, unless expressly provided otherwise, should be given their broadest possible meaning and would include welding, soldering, smelting, joining, annealing, softening, tackifying, resurfacing, peening, thermally treating, fusing, sealing, and stacking.

[0008] As used herein, unless expressly stated otherwise, “UV”, “ultra violet”, “UV spectrum”, and “UV portion of the spectrum” and similar terms, should be given their broadest meaning, and would include light in the wavelengths of from about 10 nm to about 400 nm, and from 10 nm to 400 nm.

[0009] As used herein, unless expressly stated otherwise, the terms “visible”, “visible spectrum”, and “visible portion of the spectrum” and similar terms, should be given their broadest meaning, and would include light in the wavelengths of from about 380 nm to about 750 nm, and 400 nm to 700 nm.

[0010] As used herein, unless expressly stated otherwise, the terms “blue laser beams”, “blue lasers” and “blue” should be given their broadest meaning, and in general refer to systems that provide laser beams, laser beams, laser sources, e.g., lasers and diodes lasers, that provide, e.g., propagate, a laser beam, or light having a wavelength from about 400 nm to about 500 nm.

[0011] As used herein, unless expressly stated otherwise, the terms “green laser beams”, “green lasers” and “green” should be given their broadest meaning, and in general refer to systems that provide laser beams, laser beams, laser sources, e.g., lasers and diodes lasers, that provide, e.g., propagate, a laser beam, or light having a wavelength from about 500 nm to about 575 nm.

[0012] As used herein, unless expressly stated otherwise terms such as “at least”, “greater than”, also mean “not less than” ,i.e., such terms exclude lower values unless expressly stated otherwise.

[0013] Generally, the term “about” and the symbol “~” as used herein, unless specified otherwise, are meant to encompass a variance or range of $\pm 10\%$, the experimental or instrument error associated with obtaining the stated value, and preferably the larger of these.

[0014] This Background of the Invention section is intended to introduce various aspects of the art, which may be associated with embodiments of the present inventions. Thus, the forgoing discussion in this section provides a framework for better understanding the present inventions, and is not to be viewed as an admission of prior art.

SUMMARY

[0015] There has been a long standing, increasing and unfulfilled need for better weld quality, higher speed welds, as well as, greater reproducibility, reliability, higher tolerances and more robustness in the welding of metals and, in particular, the welding of copper metals for electronic components and batteries. Included in these needs, there is the need for an improved method for welding copper to itself and other metals; and, there is a need to address the issues associated with welding stacks of copper foils and these stacks to thicker copper or aluminum parts. The present inventions, among other things, solve these needs by providing the articles of manufacture, devices and processes taught, and disclosed herein.

[0016] Thus, there is provided a method of forming a perfect weld in copper based materials, the method including: placing a work piece in a laser system; wherein the work piece includes placing a first piece of copper based material in contact with a second piece of copper material; directing a blue laser beam at the work piece, whereby a weld is formed between the first piece of copper based material and the second piece of copper based material; wherein the weld includes a HAZ and a resolidification zone; wherein a microstructure of the copper based material, the HAZ and the resolidification zone are identical.

[0017] There is further provided these welds, systems and methods having one or more of the following systems; wherein the identical microstructures shows no discernable difference in the weld that would indicate a weakness in the weld; wherein the identical microstructure includes crystal growth regions of similar size; wherein the weld is formed by conduction mode welding; wherein the weld is formed by keyhole mode welding ; wherein the first and second pieces have a thickness of from about 10 μm to about 500 μm ; wherein the first piece includes a plurality of layers of copper foil; wherein the first piece is copper metal; wherein the first piece is a copper alloy, having

from about 10 to about 95 weight percent copper; wherein the laser beam is directed to the work piece as a focused spot having power density is less than 800 kW/cm^2 ; wherein the laser beam is directed to the work piece as a focused spot having power density of is less than 500 kW/cm^2 ; wherein the laser beam is directed to the work piece as a focused spot having power density from about 100 kW/cm^2 to about 800 kW/cm^2 ; wherein the laser beam is directed to the work piece as a focused spot having power density is greater than 100 kW/cm^2 ; wherein the laser beam has a power of less than 500 W; wherein the laser beam has a power of less than 275 W; wherein the laser beam has a power of less than 150 W; wherein the laser beam has a power in the range of 150 W to about 750 W; wherein the laser beam has a power in the range of about 200W to about 500 W; wherein the laser beam is directed to the work piece as a focused spot having spot size of from about $50 \mu\text{m}$ to about $250 \mu\text{m}$; wherein the laser beam has a wavelength from about 405 nm to about 500 nm; wherein the weld is formed is splatter free; and, wherein the laser does not vaporize the workpiece.

[0018] Still further there is provided a method of forming a perfect weld in copper based materials, the method including: placing a work piece in a laser system; wherein the work piece includes placing a first piece of copper based material in contact with a second piece of copper material; directing a blue laser beam at the work piece, whereby a weld is formed between the first piece of copper based material and the second piece of copper based material; wherein the weld includes a HAZ and a resolidification zone; wherein a range of hardness for the HAZ is within a range of hardness for the copper based material.

[0019] Yet additionally, there is provided these welds, systems and methods having one or more of the following features: wherein the range of hardness for the resolidification zone is within a range of hardness for the copper based material; wherein a microstructure of the copper based material, the HAZ and the resolidification zone are identical; wherein the identical microstructures show no discernable difference in the weld that would indicate a weakness in the weld; wherein the identical microstructures shows no discernable difference in the weld that would indicate a weakness in the weld; and wherein the identical microstructure includes crystal growth regions of similar size.

[0020] Further there is provided a method of forming a perfect weld in copper based materials, the method including: placing a work piece in a laser system; wherein the work piece includes placing a first piece of copper based material in contact with a second piece of copper material; directing a blue laser beam at the work piece, whereby
5 a weld is formed between the first piece of copper based material and the second piece of copper based material; wherein the weld includes a HAZ and a resolidification zone; wherein a range of hardness for the resolidification zone is within a range of hardness for the copper based material.

[0021] Further there is provided welding copper with a blue laser with a
10 wavelength range of 405 nm to 500 nm, and the welds and products that are produced by this welding.

[0022] Moreover there is provided these welds, methods and systems that include one or more of the following features: wherein welding copper in a conduction mode; welding copper in a conduction mode with no vaporization of the weld puddle
15 during the welding process; welding copper in a conduction mode producing a micro-structure similar to the base metal with crystal growth regions that are similar in size to the base material; welding copper as in a conduction mode producing a micro-structure similar to the base metal in the Heat Affected Zone (HAZ); welding copper in a conduction mode producing a micro-structure similar to the base metal in the weld
20 bead; welding copper in a conduction mode producing a hardness similar to the base metal in the Heat Affect Zone; welding copper in a conduction mode producing a hardness similar to the base metal in the weld bead; welding copper where the micro-structure in the weld is different from the base metal; welding copper where the micro-structure in the HAZ is similar to the base metal.

[0023] Moreover there is provided these welds, methods and systems that include one or more of the following features: welding copper in a keyhole mode; welding copper in a keyhole mode where very low spatter occurs during the weld and little or no spatter is observed on the surface of the copper after the weld; welding
25 copper with a power density of 500 kW/cm^2 or greater and a weld speed that enables the keyhole to remain open; welding copper with a power density of 400 kW/cm^2 or
30 greater and a weld speed that enables the keyhole to remain open; welding copper with

a power density of 100 kW/cm^2 or greater and a weld speed that is sufficiently fast to prevent the transition to the keyhole welding regime; welding copper with a pre-heat to improve the penetration depth during the weld; welding copper with an Ar-CO₂ assist gas; welding copper with an Ar-H₂ assist gas; welding copper with Ar assist gas;
5 welding copper with air; welding copper with He assist gas; welding copper with N₂ assist gas; and welding copper with an assist gas.

[0024] Moreover there is provided these welds, methods and systems that include one or more of the following features: the laser power is modulated from 1 Hz to 1 kHz; the laser power is modulated from 1 kHz to 50 kHz; using an elongated blue
10 laser spot to keep the keyhole open; using a robot to rapidly move the spot in a circular, oscillatory or oblong oscillation motion; using a mirror mounted on a galvanometer to oscillate the spot parallel to the weld direction; using a mirror mounted on a galvanometer to oscillate the spot perpendicular to the weld direction; and using a pair of mirrors mounted on a pair of galvanometers to rapidly move the spot in a circular,
15 oscillatory, or oblong oscillation motion.

[0025] Still additionally there is provided a method of forming a keyhole weld in copper based materials, the method including: placing a work piece in a laser system; wherein the work piece comprises placing a first piece of copper based material in contact with a second piece of copper material; and, directing a blue laser beam at the
20 work piece, whereby a keyhole mode weld is formed between the first piece of copper based material and the second piece of copper based material; wherein the weld comprises a HAZ and a resolidification zone.

[0026] Moreover there is provided these welds, methods and systems that include one or more of the following features: wherein the laser power is less than 1000
25 kW for a keyhole weld; wherein the laser power is less than 500 kW for a keyhole weld; wherein the laser power is less than 300 kW for a keyhole weld; comprising elongating the laser beam to suppress spatter from the keyhole; comprising modulating the laser power to suppress spatter from the keyhole; comprising rapidly scanning the beam to suppress spatter during the keyhole mode of welding; comprising rapidly decreasing the
30 laser power after the weld is initiated either automatically or manually; comprising using a low atmospheric pressure to reduce entrapped gases and spatter during the welding

process; comprising applying a shielding gas; comprising applying a shielding gas selected from the group consisting of He, Ar, N₂; comprising applying a shielding gas mixture selected from the group consisting of Ar-H₂, N₂, N₂-H₂; and, comprising applying a shielding gas and adding hydrogen to the shielding gas to remove oxide
5 layers and promote wetting of the weld.

BRIEF DESCRIPTION OF THE DRAWINGS

[0027] FIG. 1 is a photograph of an embodiment of a spatter-free conduction mode weld of copper in accordance with the present inventions.

10 [0028] FIG. 2 is a photograph of an embodiment of a keyhole weld on copper in accordance with the present inventions.

[0029] FIG. 3 is a chart showing penetration depth vs speed for an embodiment of the present inventions for 127 μm thick copper, where the copper is fully penetrated up to the speed of 8 m/min.

15 [0030] FIG. 4 is a chart showing penetration depth vs speed for an embodiment of the present inventions for 254 μm thick copper, where the copper is fully penetrated up to the speed of 0.5 to 0.75 m/min. .

[0031] FIG. 5 is a chart showing penetration depth vs speed for an embodiment of the present inventions.

20 [0032] FIG. 6 is a chart showing penetration depth at several different speeds for embodiments of the present inventions.

[0033] FIG. 7 is an annotated photograph showing an embodiment of a conduction mode weld on a 70 μm thick copper foil in accordance with the present inventions.

25 [0034] FIG. 8 is an annotated photograph of an embodiment of a keyhole mode weld cross section in accordance with the present inventions.

[0035] FIG. 9 is the absorption curve for a variety of metals and shows the difference in the absorption between and IR laser and a visible laser.

30 [0036] FIG. 10 is a schematic view of an embodiment of a conduction mode weld propagation into the material in accordance with the present inventions.

[0037] FIG. 11 is a schematic view of an embodiment of a keyhole weld propagation into the material in accordance with the present inventions.

[0038] FIG. 12 is a perspective view of an embodiment of a part holder for laser welding in accordance with the present inventions.

5 [0039] FIG. 12A is a cross sectional view of the part holder of FIG. 12.

[0040] FIG. 13 is a perspective view of an embodiment of a part holder for to hold thin parts to make a lap weld in accordance with the present inventions.

[0041] FIG. 13A is a cross sectional view of the part holder of FIG. 13A.

10 [0042] FIG. 14 is a photograph of an embodiment of a bead on plate for a conduction mode weld in accordance with the present inventions.

[0043] FIG. 15 is a photograph of an embodiment of a stack of foils welded with the conduction welding mode in accordance with the present inventions.

[0044] FIG. 16 is a photograph of an embodiment of a bead on plate for a keyhole mode weld in accordance with the present inventions.

15 [0045] FIG. 17 is photograph of an embodiment of a stack of 40 copper foils welded with the keyhole mode in accordance with the present inventions.

[0046] FIG. 18 is a graph of the penetration depth in copper for embodiments of various power levels and various speeds in accordance with the present inventions.

20 [0047] FIG. 19 is a schematic of an embodiment of a 150 Watt blue laser system for use in performing embodiments of the present laser welding methods in accordance with the present inventions.

[0048] FIG. 20 is a schematic ray trace diagram of an embodiment of using two 150 Watt blue laser systems to make a 300 Watt blue laser system in accordance with the present inventions.

25 [0049] FIG. 21 is a schematic ray trace diagram of an embodiment of using four 150 Watt blue laser systems to make an 800 Watt blue laser system in accordance with the present inventions.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

30 [0050] In general the present inventions relate to lasers, laser beams, systems and methods for welding metals, and in particular copper and copper based

metals and alloys. Generally the present inventions further relate to the method for the application of the laser beam, the beam size, the beam power, the method for holding the parts and the method for introducing the shielding gas to prevent oxidation of the part.

5 **[0051]** In an embodiment, the present inventions provide high quality welds, high welding speeds, and both for copper based materials for electronic components, including batteries. In an embodiment, the present inventions provide high quality welds, high welding speeds, and both for copper based materials for automotive electronic components, including batteries.

10 **[0052]** In an embodiment of the present inventions, a high power blue laser source (e.g., ~450 nm) solves the problems with prior copper welding techniques. The blue laser source provides a blue laser beam, at this wavelength the absorption of copper is at ~65% enabling efficient coupling of the laser power into the material at all power levels. This system and method provides stable welding in many welding
15 techniques, including the conduction and keyhole welding modes. This system and method minimizes, reduces and preferably eliminates, vaporization, spatter, micro explosions, and combinations and variations of these.

[0053] In an embodiment blue laser welding of copper at power levels ranging from 150 Watts to 275 Watts with a spot size of ~ 200 μm achieves stable, low spatter
20 welding over all power ranges. In an embodiment of this welding system and method the welding is in the conduction mode with the resulting weld microstructure resembling the base material.

[0054] Preferably, in embodiments the laser wavelengths can be in wavelengths from 350 nm to 500 nm, the spot size (diameter, or cross section) can
25 range from 100 microns (μm) to 3 mm, and larger spot sizes are also contemplated. The spot can be circular, elliptical, linear, square or other patterns. Preferably, the laser beam is continuous. In embodiments the laser beam can be pulsed, for example from about 1 microsecond and longer.

[0055] Turning to FIG. 6 there is shown the penetration depth vs power at
30 various welding speeds. The welds were performed using a system of the type

described in Example 1. The welds were made on 500 μm Copper at 275 W power for the laser beam with no assist gas.

[0056] The photograph of FIG. 7 shows a conduction mode weld on a 70 μm thick copper foil showing the micro-structure through the HAZ and weld. The weld was made using the parameters described in Example 1. The depth of penetration of each sample was determined by first cross sectioning, then etching the sample to reveal the microstructure of the weld and HAZ areas. In addition, one of the samples was cross sectioned and the Vickers hardness across the base metal ranged from 133-141 HV, the weld bead was approximately 135 HV and the HAZ ranged from 118-132 HV. The conclusion is that hardness of the base material, HAZ and weld bead, e.g., resolidification zone, is close to the original material. In addition, the micro-structure for the conduction mode weld bead, the HAZ and the base material is very similar with minor differences in the microstructure. A weld with these characteristics has never been observed before in copper when welded with a laser or any other means. This weld quality is shown in FIG. 7 where the sample has been cross sectioned transverse to the weld and etched to reveal the microstructure.

[0057] Thus, there are embodiments of the present inventions include the method of welding copper based materials to obtain the following welds, and the resultant welds themselves. These methods and welds would include welding two or more copper based materials together, so that in the area around the weld the following the hardness of the material (as measured by a accepted and established hardness test, e.g., Vickers hardness, ASTM test, etc.) where the weld bead hardness is within the hardness of the base material, the weld bead hardness is within 1% of the hardness of the base materials, the weld bead hardness (e.g., resolidification zone) is within 5% of the hardness of the base materials, and the weld bead hardness is within 10% of the hardness of the base materials. These methods and welds would include welding two or more copper based materials together, so that in the area around the weld the following hardness of the material (as measured by a accepted and established hardness test, e.g., Vickers hardness, ASTM test, etc.) where the HAZ hardness is within the hardness of the base material, the HAZ hardness is within 1% of the hardness of the base materials, the HAZ hardness is within 5% of the hardness of the

base materials and the HAZ hardness is within 10% of the hardness of the base materials. These methods and welds would include welding two or more copper based materials together, so that in the area around the weld the microstructure of the base material, the bead (e.g., the resolidification zone), and the HAZ are identical, i.e., there are no discernable difference in the microstructure that would suggest or shown a weakness in the welded structure in the area of the weld or a weakness in the area of the weld).

[0058] Turning to FIG. 8 is the microstructure observed for a sample of the 500 μm thick copper sheet when operating in the keyhole welding mode. During the keyhole welding process, a vapor plume was clearly visible and molten copper was slowly ejected along the length of the weld. There were no indications during the weld, or after the weld of spatter from the welding process as is usually observed when welding with an IR laser. This indicates a stable, well controlled keyhole process which is suitable for creating high quality welds on electrical components. The keyhole mode weld cross section, of very high quality and uniformity, of the type shown in FIG. 8, is obtainable for a power density, as low as 800 kW/cm^2 and lower. The resolidification area [1] – [2] was from $442 \mu\text{m}$ to $301 \mu\text{m}$ and the HAZ [2] was $1314 \mu\text{m}$.

[0059] An embodiments of the present invention relates to methods, devices, and systems for the welding of copper to copper or other materials using a visible laser system to achieve benefits including an efficient heat transfer rate to the copper material; a stable weld puddle; and having these benefits in particular in either the conduction mode or keyhole mode of welding. Copper is highly absorbent in the blue wavelength range as shown in FIG. 9. The presently preferred blue laser beams and laser beam systems and methods couple the laser power into the copper in a very efficient manner. The present laser beam systems and methods heat the base material (the material to be welded, e.g., copper) faster than the heat can be conducted away from the laser spot. This provides for highly efficient, and excelled weld properties for conduction mode laser welding, i.e., the material in the laser beam is rapidly heated to the melting point and maintained at the melting point by the continuous laser beam resulting in a stable weld bead being formed. In the present conduction mode welding, the metal is melted rapidly, but the penetration depth of the weld is dictated by the

thermal diffusion into the material and progresses with a spherical shape into the material. This is shown in FIG. 10, which shows a schematic of an embodiment of a conductive mode welding 1000, showing the direction of the weld with arrow 1004. The laser beam 1001, e.g., blue wavelength, is focused on to, and maintains a weld pool 1002. Behind the weld pool 1002 is a solid weld material 1003. The base material, e.g., copper metal or alloy, is below the weld. A shielding gas stream 1005 is also used.

[0060] An embodiment of the present inventions relates to keyhole welding of copper with a blue laser system. These methods and systems open new possibilities for welding thick copper materials as well as stacks, including thick stacks, of copper foils. This keyhole mode of welding occurs when the laser energy is absorbed so rapidly that it melts and vaporizes the material being welded. The vaporized metal creates a high pressure in the metal being welded, opening a hole or capillary where the laser beam can propagate and be absorbed. Once the keyhole mode is initiated, deep penetration welding can be achieved. The absorption of the laser beam changes from the initial absorption of 65% for a blue laser in copper to 100% absorption in the keyhole. The high absorption can be attributed to multiple reflections off the walls of the keyhole, where the laser beam undergoes continuous absorption. When combined with the high absorptivity of the copper at the blue wavelength, the power required to initiate the keyhole and maintain it is substantially lower than when using an IR laser. Turning to FIG. 11, which shows a schematic of an embodiment of a keyhole mode weld 2000, showing the direction of the weld with arrow 2007. There is a metal/vapor plasma in the keyhole 2006. The blue laser beam 2002, creates a plasma cloud 2002, a weld pool 2003, and a solid weld metal 2004. A shielding gas stream 2005 is also used.

[0061] Comparing the keyhole weld of FIG. 11 with the conduction mode weld of FIG. 10, the walls of the final weld resolidification zone in the keyhole weld are more vertical through the part or base material than the conduction mode weld.

[0062] Preferably, the high power laser beams, (e.g., visible, green and blue laser beams), for the embodiments of the present systems and methods are focused, or have the ability to be focused through the optics in the system, to a spot size of about 50 μm or more and have a power of at least 10 W or more. The powers for the laser beams, including the blue laser beams may be 10 W, 20 W, 50 W, 100 W, 10 – 50 W,

100 – 250 W, 200 – 500 W, and 1,000 W, higher and lower powers are contemplated, and all wavelengths within these ranges. The spot sizes (longest cross sectional distance, which for a circle is the diameter) for these powers and laser beams may be from about 20 μm to about 4 mm, less than about 3 mm, less than about 2 mm, from
5 about 20 μm to about 1 mm, about 30 μm to about 50 μm , about 50 μm to about 250 μm , about 50 μm to about 500 μm , about 100 μm to about 4000 μm , large and smaller spots are contemplated, and all sized within these ranges. The power density of the laser beam spots may be from about 50 kW/cm^2 to 5 MW/cm^2 , about 100 kW/cm^2 to 4.5 MW/cm^2 , about 100 kW/cm^2 to 1000 kW/cm^2 , about 500 kW/cm^2 to 2 MW/cm^2 , greater
10 than about 50 kW/cm^2 , greater than about 100 kW/cm^2 , greater than about 500 kW/cm^2 , greater than about 1000 kW/cm^2 , greater than about 2000 kW/cm^2 , and higher and lower power densities, and all power densities within these ranges. Welding speeds of from about 0.1 mm/sec to about 10 mm/sec for copper, and slower and faster speeds depending upon various conditions, and all speeds within these ranges. The speed
15 depends upon the thickness of the material being welded, thus speed per thickness mm/sec/thickness in mm can be, for example, from 0.1/sec to 1000/sec for 10 μm to 1 mm thickness copper.

[0063] Embodiments of the present methods and systems can use one, two, three or more laser beams to form the welds. The laser beams can be focused on the
20 same general area to initiate the weld. The laser beam spots can be overlapping, and can be coincident. The plurality of laser beams can be used simultaneously; and coincident and simultaneous. A single laser beam can be used to initiate the weld followed by addition of the second laser beam. A plurality of laser beams can be used to initiate the weld followed by using less beams, e.g., a single beam, to continue the
25 weld. The laser beams in this plurality of laser beams can be different powers or the same powers, the power densities can be different or the same, the wavelengths can be different or the same, and combinations and variations of these. The use of additional laser beams can be a simultaneous, or sequentially. Combinations and variations of these embodiments of using multiple laser beams may also be used. The use of
30 multiple laser beams can suppress spatter from the weld, and can do so in deep penetration welding methods.

[0064] In embodiments hydrogen gas, H₂, can be mixed with an inert gas to remove oxide layers from the base material during the welding process. The hydrogen gas is flowed over the weld area. The hydrogen gas also promotes wetting of the weld. The hydrogen gas can be added to, or form a mixture with, the shielding gas and be applied to the weld as a part of the shielding gas. These mixtures would include for example, Ar-H₂, He-H₂, N₂-H₂,

[0065] FIG. 18 provides examples of the penetration depth, laser beam power and welding speed on copper for various embodiments of laser system configurations and material thicknesses ranging from 127 μm to 500 μm

Methods for conduction mode welding of copper, copper alloys and other metals with a blue laser system

[0066] The present systems overcome the problems and difficulties associated with IR welding, when applied to copper based materials. The high absorptivity (65%) of copper at blue wavelengths of the present laser beam and beam spots overcomes the thermal diffusivity of the material, and can do so at relatively low power levels ~ 150 Watts. The present blue laser beam's interaction with copper allows the copper to readily reach its melt point and allow a wide processing window.

[0067] In an embodiment a steady conduction mode weld, is performed and high-quality welds are obtained at a steady and rapid rate, through the use of a part holding devices or fixture.

[0068] A welding fixture is used to hold the material to be welded in place during the thermal transient induced in the parts by the laser beam. The fixture in FIGS. 12 and 12A, which are a prospective and cross-sectional view respectively, of an embodiment of a linear section of a welding clamp that can be used for lap, butt and even edge welds. The welding fixture 4000 has a base plate or support structure 4003. Attached to the baseplate 4003 are two clamp members, or hold downs, 4001. The hold downs 4001 have a tab that rests on the surface of the baseplate 4002, and a free end that contacts and holds the work piece(s) to be welded. There is a slot, e.g., 2 mm wide x 2 mm deep, in the baseplate 4002 in the area between the free ends for the hold downs 4001. Four bolts, e.g., 4004, (other types of adjusting tightening devices may

also be used) adjust, tighten and hold the clamps against the work piece, thus holding or fixing the work piece.

[0069] The preferred material for this fixture is a low thermal conductivity material such as stainless steel because it is sufficiently stiff to apply the clamping pressure required to hold the parts in place during the weld. In embodiments the clamps, the baseplate and both can have insulating qualities or effects on the work piece during the welding process. The use of a material having low thermal conductivity for the fixture prevents, minimizes and reduces the heat that is deposited into the part form being rapidly conducted away by the fixture itself. This provides added benefits when welding high thermal conductivity materials such as copper. Therefore, the material selected for the clamp, the width of the clamp and the gap under the parts are all parameters which determines the depth of penetration of the weld, the width of the weld bead and the overall quality of the weld bead. Turning to FIG. 14, there is shown a cross section (after etching) where the conduction mode weld can be identified by the circular shape 6001 of the weld bead in the base material, e.g., the work piece. The weld takes this shape because of the isotropic nature of the heat transfer process in copper or any other material when the heat is applied at the top surface of the part.

[0070] In a preferred embodiment, the baseplate 4002 of the fixture 4000 is constructed of stainless steel, a 2 mm wide gap 4003 is cut into the baseplate to be positioned just below the weld zone and flooded with an inert gas such as Argon, Helium, or Nitrogen (as a covering or shielding gas) to minimize oxidization of the back surface of the weld. The covering gas can be a mixture of hydrogen and an inert gas. The clamps 4001 are designed to put pressure on the parts to be welded at 2 mm from the edges of the gap 4003 in the baseplate 4002. Thus, in this embodiment a 6 mm wide area of the parts to be welded is open to the laser beam (recognizing that the laser beam will be a slight distance away from the clamp). This positioning of the clamps allows the laser beam easy access to the surface as well as a tight clamping of the parts. This type of clamp is the preferred method for butt welding two foils or sheets of copper together varying in thickness from 50 μm to multiple mm. This fixture is also suited to lap welding two thicker copper plates together ranging from 200 μm to multiple mm. The amount of clamping pressure is very important, and depending on the amount

of laser power, the speed of the weld, the thickness of the parts and the type of weld being performed the clamping bolts may be torqued to 0.05 Newton-m (Nm), up to 3 Nm, or more for thicker materials. This torque value is highly dependent on the bolt size, the thread engagement and the distance from the bolt center to the clamping point.

5 **[0071]** In an embodiment high quality and excellent welds are obtained by providing sufficient clamping force to prevent movement of the parts during the weld while minimizing the parasitic heat loss to the fixture itself. It should be understood that the embodiment of the fixture in FIGS. 12 and 12A, represents a cross section of a straight portion of a weld fixture and may be designed into any arbitrary 2-D path (e.g., -
10 S - , -C -. -W – etc.) for welding any types of shapes together. In another embodiment, the fixture may be preheated, or heated during the welding process to increase the speed or depth of penetration of the weld while reducing the parasitic heat losses to the fixture. The fixture when heated to a few 100 °C can improve the weld speed, or depth of penetration and quality by a factor or two or more. The shielding gas for the top side
15 of the weld is delivered longitudinally from the front of the weld travel direction to the back of the weld travel direction as shown in FIG. 10. A bead on plate conduction mode weld is shown in FIG. 14 that was performed with this fixture 4000 on a sheet of 254 μm thick copper. The freeze pattern of the weld bead shows the spherical melt pattern typical of this type of weld.

20 **[0072]** Lap welding two parts using the conduction mode welding process requires the parts to be placed and held in intimate contact. The two parts (collectively the work piece) can be placed in a fixing device, preferably of the type shown in FIGS. 13 and 13A, which are perspective and cross-sectional view respectively of fixture 5000. The fixture 5000 has a baseplate 5003 and two clamps 5002. The clamps have four
25 slots, e.g., 5010 that correspond to hold down bolts, e.g., 5001. In this manner the position of the clamps relative to the work piece, relative to each other can be adjusted and fixed, as well as the amount of clamping force or pressure. The clamps can have magnets to assist in their positioning, and fixation. The clamps 5002 have internal channels, e.g., 5004 for transporting shielding gas. The channels 5004 are in fluid
30 communication with shielding gas outlets, e.g., 5005. The shielding gas outlets and the shielding gas channels from a shielding gas delivery system within the clamps. Thus,

the gas delivery system is, and is through, a row of holes along the length of the clamp that deliver an inert gas such as Argon, Helium, or Nitrogen. Argon is the preferred gas because it is heavier than air and will settle on the part, displacing the oxygen and preventing oxidation of the upper surface. A small amount of Hydrogen can be added to the inert gas to promote scavenging of the oxide layer on the part and promote the wetting of the parts during the melting process.

[0073] There is also an insert 5006, which is used to force the individual foils in a stack of foils to keep and maintain contact with each other in the stack. The insert 5006 can stretch and force the foils into tight, and uniform contact with each other. In the embodiment of FIGS. 13 and 13A, the insert 5006 is an inverted V shape. It can be curved, humped or other shaped depending upon the stack of foils, and their individual thicknesses. Additionally, in the embodiment of FIGS. 13 and 13A the insert 5006 is adjacent to, but not covered by the clamps 5002. The insert can be removed from the ends of the clamps, or one or both of the clamps may partially cover the insert.

[0074] In the preferred embodiment, the baseplate 5000 is made from stainless steel, as are the clamps 5002. The fixation device can be made from a ceramic or thermally insulating material. The hump 5006 provides pressure from the bottom of the weld to keep the overlapping plates (two, three, tens, etc.) in intimate contact. In this embodiment, a provision for shielding gas is built into the clamps (2) in the form of a row of holes along the length of the clamp that deliver an inert gas such as Argon, Helium, or Nitrogen. Argon is the preferred gas because it is heavier than air and will settle on the part, displacing the oxygen and preventing oxidation of the upper surface. The insert hump 5006 in the baseplate 5003 may also have a series of channels, holes or slots, to deliver a cover or shielding gas to the backside of the weld to prevent oxidation. The fixture 5000, as shown in the figures, represents a cross section of a straight portion of a weld and may be designed into any arbitrary 2-D path for welding arbitrary shapes together. In this application, the torque values for the bolts can be important, depending upon the nature of the work piece, too low of a torque value, e.g., 0.1 Nm, and the parts may not remain in contact, too high of a torque value >1 Nm and the parasitic heat transfer reduces the efficiency of the welding process, reducing penetration and weld bead width.

Method for keyhole mode welding copper, copper alloys and other metals with a blue laser system

[0075] The blue laser light has a much higher level of absorption than the IR laser (65%) and can initiate a keyhole weld at a relatively low power level of 275 Watts (in contrast to 2,000 to 3,000 W required for an IR system to initiate the keyhole welding process. Upon initiation the IR system will further face the problem of runaway, among other problems.) As the keyhole mode is initiated with the blue laser system, the absorption increases, now it is not a runaway process because it increases from 65% to about 90% and to 100%. Thus, the present keyhole welding process has a very different absorption time profile from IR. The present blue keyhole welding process has an absorption time profile from initiation to advancing the weld that is 35% or less. The startup of the blue laser welding process and the transition to a continuous weld, using the present laser welding systems, is accomplished without having to rapidly changing the power level of the laser or the weld speed, as required when using an IR laser to prevent spatter. A high-speed video of the start of the keyhole weld when using a blue laser shows a stable process, capable of welding multiple layers of copper foils and plates with minimal to no spatter ejected from the keyhole. Cross sections of two keyhole welded sample are shown in FIG. 16 and 17, where the material freeze pattern is clearly different from the shape of the conduction mode welded sample shown in FIG. 14. The formation of material freeze patterns perpendicular to the surface of the material, as seen in FIG. 16 and 17, is different from a conduction mode weld because the heat transfer occurs along the entire length of the keyhole which penetrates the surface of the part and extends to the final weld depth. This contrasts to the conduction mode weld, where all the laser energy is deposited on the surface of the material.

[0076] The keyhole welding process like the conduction mode welding process requires the parts to be held in a fixture to prevent any movement during the weld. The keyhole mode is typically used in a lap weld configuration, where the keyhole penetrates through the parts, welding a stack of two or more parts together (e.g., as see in FIG. 17).

[0077] The laser system of FIG. 20, can produce a 275 W blue laser beam, with a power density at the spot of 800 kW/cm^2 . The laser system of FIG. 20 has a first

laser module 1201, and a second laser module 1202, laser beams leave the laser module and follow laser beam paths as shown by ray trace 1200. The laser beams go through turning mirrors 1203, 1205 and through a focusing lens configuration 1205, having a 100 mm focusing lens and 100 mm protective window. The focusing lens in the configuration 1205 creates spot 1250.

[0078] The laser system shown in FIG. 21, can be used to create a 400 μm spot or a 200 μm spot. The laser system of FIG. 21 consists of 4 laser modules 1301, 1302, 1303, 1304. The laser modules can each be of the type disclosed and taught in US Patent Publ. No. 2016/0322777, the entire disclosure of which is incorporated herein by reference. For example, the modules can be of the type shown in FIG. 19, where composite beam from each of the laser diode subassemblies, 210, 210a, 210b, 210c, propagates to a patterned mirror, e.g., 225, which is used to redirect and combine the beams from the four laser diode subassemblies into single beams. A polarization beam folding assembly 227 folds the beam in half in the slow axis to double the brightness of the composite laser diode beam. The telescope assembly 228 either expands the combined laser beams in the slow axis or compresses the fast axis to enable the use of a smaller lens. The telescope 228 shown in this example expands the beam by a factor of 2.6 $\times$, increasing its size from 11 mm to 28.6 mm while reducing the divergence of the slow axis by the same factor of 2.6 $\times$. If the telescope assembly compresses the fast axis then it would be a 2 $\times$ telescope to reduce the fast axis from 22 mm height (total composite beam) to 11 mm height giving a composite beam that is 11 mm $\times$ 11 mm. This is the preferred embodiment, because of the lower cost. An aspheric lens 229 focuses the composite beam.

[0079] It should be understood that at 500 Watts and a 200 μm spot, the power density is $>1.6 \text{ MW}/\text{cm}^2$, which is substantially above the keyhole welding threshold at this wavelength. At this power density, even the blue laser has the potential to create spatter and porosity in the weld. However, since the absorption is well controlled, the ability to suppress, control or eliminate, the spatter is possible. The first method for suppressing the spatter is to reduce the power level once the spatter process begins, while holding the welding speed constant. The second method for suppressing the spatter is to elongate the weld puddle to allow the shielding gases and

vaporized metal to exhaust from the keyhole, producing a spatter free, defect free weld. The third method for suppressing the spatter is to wobble the blue laser beam using either a set of mirrors mounted on a set of galvanometer motors or a robot. The fourth method for suppressing the spatter is to reduce the pressure of the welding environment including the use of a vacuum. Finally, the fifth method for suppressing the spatter is to modulate the laser beam power over a range of 1 Hz to 1 kHz, or as high as 50 kHz. Preferably, the welding parameters are optimized to minimize the spatter during the process.

[0080] In general, embodiments of the present inventions relate to laser processing of materials, laser processing by matching preselected laser beam wavelengths to the material to be processed to have high or increased levels of absorptivity by the materials, and in particular laser welding of materials with laser beams having high absorptivity by the materials.

[0081] An embodiment of the present invention relates to using laser beams having visible laser beams, wavelengths from 350 nm to 700 nm, to weld or otherwise join through laser processing, materials that have higher absorptivity for these wavelengths. In particular laser beam wavelengths are predetermined based upon the materials to be laser processed to have absorption of at least about 30%, at least about 40%, at least about 50% and at least about 60%, or more and from about 30% to about 65%, from about 35% to 85%, about 80%, about 65%, about 50, and about 40%. Thus, for example, laser beams having wavelengths from about 400 nm to about 500 nm are used to weld gold, copper, brass, silver, aluminum, nickel, alloys of these metals, stainless steel, and other metals, materials, and alloys.

[0082] The use of a blue laser, e.g., about 405 to about 495 nm wavelength, to weld materials such as gold, copper, brass, silver, aluminum, nickel, nickel plated copper, stainless steel, and other, materials, plated materials and alloys, is preferred because of the high absorptivity of the materials at room temperature, e.g., absorptivities of greater than about 50%. One of several advantages of the present inventions is the ability of a preselected wavelength laser beam, such as the blue laser beam, that is better able to better couple the laser energy into the material during the laser operation, e.g., the welding process. By better coupling the laser energy to the

material being welded, the chance of a run away process is greatly reduced and preferably eliminated. Better coupling of the laser energy also allows for a lower power laser to be used, which provides cost savings. Better coupling also provides for greater control, higher tolerances and thus greater reproducibility of welds. These features, which are not found in with IR lasers and IR laser welding operations, are important, to among other products, products in the electronics and power storage fields.

[0083] In an embodiment a blue laser that operates in a CW mode is used. CW operation can be preferred over pulsed lasers, in many applications, because of the ability to rapidly and fully modulate the laser output and control the welding process in a feedback loop, resulting in a highly repeatable process with optimum mechanical and electrical characteristics.

[0084] In an embodiment of the present inventions involve the laser processing of one, two or more components. The components may be made from any type of material that absorbs the laser beam, e.g., the laser beams energy, plastics, metals, composites, amorphous materials, and other types of materials. In an embodiment the laser processing involves the soldering together of two metal components. In an embodiment the laser processing involves the welding together of two metal components.

[0085] In an embodiment there is provided the tools, systems and methods wherein the laser welding operation is selected from the group consisting autogenous welding, laser-hybrid welding, keyhole welding, lap welding, fillet welding, butt welding and non-autogenous welding.

[0086] Laser welding techniques may be useful in many varied situations, and in particular where welding is needed for forming electrical connections, and in particular power storage devices, such as batteries. Generally, embodiments of the present laser welding operations and systems include visible wavelength, and preferably blue wavelength, lasers that can be autogenous which means only the base material is used and is common in keyhole welding, conduction welding, lap welding, fillet welding and butt welding. Laser welding can be non-autogenous where a filler material is added to the melt puddle to “fill” the gap or to create a raised bead for

strength in the weld. Laser welding techniques would also include laser material deposition ("LMD").

[0087] Embodiments of the present laser welding operations and systems include visible wavelength, and preferably blue wavelength, lasers that can be hybrid welding where electrical current is used in conjunction with a laser beam to provide more rapid feed of filler material. Laser Hybrid welding is by definition non-autogenous.

[0088] Preferably, in some embodiments active weld monitors, e.g., cameras, can be used to check the quality of the weld on the fly. These monitors can include for example x-ray inspection and ultrasonic inspection systems. Furthermore, on stream beam analysis and power monitoring can be utilized to have full understanding of system characteristics and the operations characterizations.

[0089] Embodiments of the present laser systems can be a hybrid system that combine the novel laser systems and methods with conventional milling and machining equipment. In this manner material can be added and removed during the manufacturing, building, refinishing or other process. Examples of such hybrid systems, using other embodiments of laser systems, which have been invented by one or more of the present inventors, is disclosed and taught in US Patent Application Serial No. 14/837,782, the entire disclosure of which is incorporated herein by reference.

[0090] Typically, in embodiments, laser welding uses a very low flow of gas to keep the optics clean, an air knife to keep the optics clean or an inert environment to keep the optics clean. Laser welding can be performed in air, an inert environment, or other controlled environment, e.g., N₂.

[0091] Embodiments of the present invention can find great advantage in welding copper materials, which would include copper, pure copper, alloys of copper and all materials having sufficient amounts of copper to have at about a 40% to 75% absorption in the blue laser wavelengths, and preferably about 400 nm to about 500 nm.

[0092] There are two preferred autogenous welding modes, and autogenous welds that they produce, that are performed with embodiments of the present laser systems and processes, a conduction weld and a keyhole weld. The conduction weld is when a laser beam with a low intensity ($< 100 \text{ kW/cm}^2$) is used to weld two pieces of metal together. Here the two pieces of metal may be butted up to each other,

overlapping to one side and completely overlapping. The conduction weld tends not to penetrate as deeply as a keyhole weld and it generally produces a characteristic “spherical” shape weld joint for a butt weld, which is very strong. However, a keyhole weld occurs with a relatively high laser beam intensity ($> 500 \text{ kW/cm}^2$) and this weld can penetrate deep into the material and often through multiple layers of materials when they are overlapped. The exact threshold for the transition from conduction mode to key-hole mode has not yet been determined for a blue laser source, but the key-hole weld has a characteristic “v” shape at the top of the material with a near parallel channel of refrozen material penetrating deep into the material. The key-hole process relies on the reflection of the laser beam from the sides of the molten pool of metal to transmit the laser energy deep into the material. While these types of welds can be performed with any laser, it is expected that the blue laser will have a substantially lower threshold for initiating both of these types of welds than an infrared laser.

[0093] The welding of electroplated material using blue laser operations to weld these materials is contemplated, including the blue laser welding of electroplated materials, such as materials electroplated with copper, electroplated with platinum, and electroplated with other conductive material.

[0094] The following examples are provided to illustrate various embodiments of the present laser systems and operations and in particular a blue laser system for welding components, including components in electronic storage devices. These examples are for illustrative purposes, may be prophetic, and should not be viewed as, and do not otherwise limit the scope of the present inventions.

[0095] EXAMPLE 1

[0096] The laser source is a high power blue direct diode laser capable of 0-275 Watts. The beam is delivered through a 1.25X beam expander and focused by a 100mm aspheric lens. The spot diameter on the workpiece is $200\mu\text{m} \times 150\mu\text{m}$ which produces a power density at maximum power of 1.2MW/cm^2 . A stainless steel fixture is used to hold the samples in place and tests were performed with He, Ar, Ar-CO₂ and Nitrogen, all were beneficial, with the best results achieved with Ar-CO₂.

[0097] EXAMPLE 1A

[0098] Using the system of Example 1, initial test results produced high quality conduction mode welds at power levels of 150 Watts on the copper surface. A series of Bead on Plate (BOP) tests were conducted to characterize the welds produced by the high power blue laser source. FIG. 1 shows the chevron pattern for a conduction mode weld, the unique characteristics of this weld include; no spatter during the welding process, a microstructure that resembles the base material and hardness of the weld is like the base material. FIG. 1 shows the BOP formed when welding with a blue laser at 150 Watts on a 70 μ m thick copper foil.

[0099] EXAMPLE 1B

[00100] Using the system of Example 1 and scaling the power output of the laser to 275 Watts increased the power density to 1.2 MW/cm² which is sufficient power density to initial keyhole welding in copper. FIG. 2 shows an example of a keyhole weld on a 500 μ m thick copper sample. During the keyhole process, the vapor pressure developed in the keyhole forces molten copper out of the weld bead. This can be seen in FIG. 2 where the ejected copper lines the edges of the weld bead. This ejection process is stable and does not result in micro-explosions in the material and consequently it does not produce the spatter patterns observed when welding copper with an IR laser source.

[00101] EXAMPLE 1C

Using the system of Example 1, welding experiments were performed for copper thicknesses ranging from 127-500 μ m. FIGS. 3 – 5 summarize the results of these BOP tests. FIG. 3 shows full penetration up to 9 m/min at 275W followed by a falloff of the penetration depth with speed as expected. FIG. 4 shows BOP results with full penetration up to 0.6m/min with no-assist gas and 0.4m/min when using Ar-CO₂ cover gas. FIG. 5 shows depth of penetration vs. Speed for 500 μ m Copper at 275W.

[00102] EXAMPLE 2

[00103] The fixture 5000 of FIGS. 13 and 13A is used to successfully lap weld a stack of 2 copper foils, 178 μ m thick with a conduction mode weld. The fixture when heated to a few 100 °C results in an improvement in the weld speed and quality by a factor or two or more because the energy lost to heating the part during the weld is now

provided by the pre-heat. The shielding gas for the top side of the weld is delivered at the front of the weld travel direction to the back of the weld travel direction as shown in FIG. 10.

[00104] EXAMPLE 3

5 **[00105]** Two 125 μm thick copper plates were lap welded together using the fixture 5000, with a conduction mode weld. This weld is shown in the cross-section photograph of FIG. 15.

[00106] EXAMPLE 4

10 **[00107]** Using the fixture 5000 shown in FIGS. 13 and 13A, a stack of 40 copper foils, 10 μm thick are welded with no porosity and no defects. A cross section of this weld is shown in FIG. 17. Welding this stack depends on how the foils are prepared, how the foils are clamped and how much torque is applied to the clamps. The foils are sheared and flattened, then they are cleaned with alcohol to remove any manufacturing or handling oils and finally stacked in the fixture. The clamping bolts
15 5001 are torqued to 1 Nm to insure the parts are held firmly in place during the welding process. The laser used to weld these parts consist of four of the 150-Watt lasers shown in FIG. 19 optically combined as shown in FIG. 21 to create a 500-Watt laser system. This laser produces a 400 μm spot with an average power density of 400 kW/cm^2 , and a peak power density sufficient to initiate the keyhole welding process.

20 **HEADINGS AND EMBODIMENTS**

[00108] It should be understood that the use of headings in this specification is for the purpose of clarity, and is not limiting in any way. Thus, the processes and disclosures described under a heading should be read in context with the entirety of this specification, including the various examples. The use of headings in this specification
25 should not limit the scope of protection afford the present inventions.

[00109] It is noted that there is no requirement to provide or address the theory underlying the novel and groundbreaking processes, materials, performance or other beneficial features and properties that are the subject of, or associated with, embodiments of the present inventions. Nevertheless, various theories are provided in
30 this specification to further advance the art in this area. The theories put forth in this specification, and unless expressly stated otherwise, in no way limit, restrict or narrow

the scope of protection to be afforded the claimed inventions. These theories many not be required or practiced to utilize the present inventions. It is further understood that the present inventions may lead to new, and heretofore unknown theories to explain the function-features of embodiments of the methods, articles, materials, devices and system of the present inventions; and such later developed theories shall not limit the scope of protection afforded the present inventions.

[00110] The various embodiments of systems, equipment, techniques, methods, activities and operations set forth in this specification may be used for various other activities and in other fields in addition to those set forth herein. Additionally, these embodiments, for example, may be used with: other equipment or activities that may be developed in the future; and with existing equipment or activities which may be modified, in-part, based on the teachings of this specification. Further, the various embodiments set forth in this specification may be used with each other in different and various combinations. Thus, for example, the configurations provided in the various embodiments of this specification may be used with each other; and the scope of protection afforded the present inventions should not be limited to a particular embodiment, configuration or arrangement that is set forth in a particular embodiment, example, or in an embodiment in a particular Figure.

[00111] The invention may be embodied in other forms than those specifically disclosed herein without departing from its spirit or essential characteristics. The described embodiments are to be considered in all respects only as illustrative and not restrictive.

In the Claims

1. A method of forming a perfect weld in copper based materials, the method comprising:

5 a. placing a work piece in a laser system; wherein the work piece comprises placing a first piece of copper based material in contact with a second piece of copper material;

10 b. directing a blue laser beam at the work piece, whereby a weld is formed between the first piece of copper based material and the second piece of copper based material; wherein the weld comprises a HAZ and a resolidification zone; and,

c. wherein a microstructure of the copper based material, the HAZ and the resolidification zone are identical.

2. The method of claim 1, wherein the identical microstructures shows no discernable difference in the weld that would indicate a weakness in the weld.

15 3. The method of claim 1, wherein the identical microstructure comprises crystal growth regions of similar size.

4. The method of claim 1, wherein the weld is formed by conduction mode welding.

5. The method of claim 1, wherein the first and second pieces have a thickness of from about 10 μm to about 500 μm .

20 6. The method of claim 1, wherein the first piece comprises a plurality of layers of copper foil.

7. The method of claim 1, wherein the first piece is copper metal.

8. The method of claim 1, wherein the first piece is a copper alloy, having from about 10 to about 95 weight percent copper.

9. The method of claim 1, wherein the laser beam is directed to the work piece as a focused spot having power density is less than 800 kW/cm^2 .
10. The method of claim 1, wherein the laser beam is directed to the work piece as a focused spot having power density of is less than 500 kW/cm^2 .
- 5 11. The method of claim 1, wherein the laser beam is directed to the work piece as a focused spot having power density from about 100 kW/cm^2 to about 800 kW/cm^2 .
12. The method of claim 1, wherein the laser beam is directed to the work piece as a focused spot having power density from about 800 kW/cm^2 to about 5 MW/cm^2 .
- 10 13. The method of claim 1, wherein the laser beam is directed to the work piece as a focused spot having power density is greater than 100 kW/cm^2 .
14. The method of claim 1, wherein the laser beam has a power of less than 500 W .
15. The method of claim 1, wherein the laser beam has a power of less than 275 W .
16. The method of claim 1, wherein the laser beam has a power of less than 150 W .
- 15 17. The method of claim 1, wherein the laser beam has a power in the range of 150 W to about 750 W .
18. The method of claim 1, wherein the laser beam has a power in the range of about 200 W to about 500 W .
19. The method of claim 1, wherein the laser beam is directed to the work piece as a focused spot having spot size of from about $50 \mu\text{m}$ to about $250 \mu\text{m}$.
- 20 20. The method of claim 1, wherein the laser beam has a wavelength from about 405 nm to about 500 nm .
21. The method of claim 1, wherein the weld is formed is splatter free.
22. The method of claim 1, wherein the laser does not vaporize the work piece.

23. A method of forming a perfect weld in copper based materials, the method comprising:

- a. placing a work piece in a laser system; wherein the work piece comprises placing a first piece of copper based material in contact with a second piece of copper material;
- b. directing a blue laser beam at the work piece, whereby a weld is formed between the first piece of copper based material and the second piece of copper based material; wherein the weld comprises a HAZ and a resolidification zone; and,
- c. wherein a range of hardness for the HAZ is within a range of hardness for the copper based material.

24. The method of claim 23, wherein the range of hardness for the resolidification zone is within a range of hardness for the copper based material.

25. The method of claim 23, wherein a microstructure of the copper based material, the HAZ and the resolidification zone are identical.

26. The method of claim 25, wherein the identical microstructures show no discernable difference in the weld that would indicate a weakness in the weld.

27. The method of claim 26, wherein the identical microstructures shows no discernable difference in the weld that would indicate a weakness in the weld.

28. The method of claim 26, wherein the identical microstructure comprises crystal growth regions of similar size.

29. The method of claim 23, wherein the weld is formed by conduction mode welding.

30. The method of claim 23, wherein the first and second pieces have a thickness of from about 10 μm to about 500 μm .

31. The method of claim 23, wherein the first piece comprises a plurality of layers of copper foil.

32. The method of claim 23, wherein the first piece is copper metal.

33. The method of claim 23, wherein the first piece is a copper alloy, having from
5 about 10 to about 95 weight percent copper.

34. The method of claim 23, wherein the laser beam is directed to the work piece as a focused spot having power density is less than 2000 kW/cm^2 .

35. The method of claim 23, wherein the laser beam is directed to the work piece as a focused spot having power density of is less than 500 kW/cm^2 .

10 36. The method of claim 23, wherein the laser beam is directed to the work piece as a focused spot having power density from about 100 kW/cm^2 to about 4500 kW/cm^2 .

37. The method of claim 23, wherein the laser beam is directed to the work piece as a focused spot having power density is greater than 100 kW/cm^2 .

15 38. The method of claim 23, wherein the laser beam has a power of less than 500 W.

39. The method of claim 23, wherein the laser beam has a power of less than 275 W.

40. The method of claim 23, wherein the laser beam has a power of less than 150 W.

41. The method of claim 23, wherein the laser beam has a power in the range of 150 W to about 750 W.

20 42. The method of claim 23, wherein the laser beam has a power in the range of about 200W to about 500 W.

43. The method of claim 23, wherein the laser beam is directed to the work piece as a focused spot having spot size of from about $50 \mu\text{m}$ to about $250 \mu\text{m}$.

44. The method of claim 23, wherein the laser beam is directed to the work piece as a focused spot having spot size of from about 100 μm to about 500 μm .

45. The method of claim 23, wherein the laser beam has a wavelength from about 405 nm to about 500 nm.

5 46. The method of claim 23, wherein the weld is formed is splatter free.

47. The method of claim 23, wherein the laser does not vaporize the workpiece.

48. A method of forming a perfect weld in copper based materials, the method comprising:

10 a. placing a work piece in a laser system; wherein the work piece comprises placing a first piece of copper based material in contact with a second piece of copper material;

b. directing a blue laser beam at the work piece, whereby a weld is formed between the first piece of copper based material and the second piece of copper based material; wherein the weld comprises a HAZ and a
15 resolidification zone;

c. wherein a range of hardness for the resolidification zone is within a range of hardness for the copper based material; and,

d. wherein a microstructure of the copper based material, the HAZ and the resolidification zone are identical .

20 49. The method of claim 48, wherein the identical microstructures show no discernable difference in the weld that would indicate a weakness in the weld.

50. The method of claim 48, wherein the identical microstructures shows no discernable difference in the weld that would indicate a weakness in the weld.

25 51. The method of claim 48, wherein the identical microstructure comprises crystal growth regions of similar size.

52. The method of claim 48, wherein the weld is formed by conduction mode welding.

53. The method of claim 48, wherein the first and second pieces have a thickness of from about 10 μm to about 500 μm .

54. The method of claim 48, wherein the first piece comprises a plurality of layers of copper foil.

55. The method of claim 48, wherein the first piece is copper metal.

56. The method of claim 48, wherein the first piece is a copper alloy, having from about 10 to about 95 weight percent copper.

57. The method of claim 48, wherein the laser beam is directed to the work piece as a focused spot having power density is less than 800 kW/cm^2 .

58. The method of claim 48, wherein the laser beam is directed to the work piece as a focused spot having power density of is less than 500 kW/cm^2 .

59. The method of claim 48, wherein the laser beam is directed to the work piece as a focused spot having power density from about 100 kW/cm^2 to about 3000 kW/cm^2 .

60. The method of claim 48, wherein the laser beam is directed to the work piece as a focused spot having power density is greater than 100 kW/cm^2 .

61. The method of claim 48, wherein the laser beam has a power of less than 500 W.

62. The method of claim 48, wherein the laser beam has a power of less than 275 W.

63. The method of claim 48, wherein the laser beam has a power of less than 150 W.

64. The method of claim 48, wherein the laser beam has a power in the range of 150 W to about 750 W.

65. The method of claim 48, wherein the laser beam has a power in the range of about 200 W to about 500 W.

66. The method of claim 48, wherein the laser beam is directed to the work piece as a focused spot having spot size of from about 50 μm to about 250 μm .

67. The method of claim 48, wherein the laser beam has a wavelength from about 405 nm to about 500 nm.

5 68. The method of claim 48, wherein the weld is formed is splatter free.

69. The method of claim 48, wherein the laser does not vaporize the work piece.

70. A method of forming a keyhole weld in copper based materials, the method comprising:

- 10 a. placing a work piece in a laser system; wherein the work piece comprises placing a first piece of copper based material in contact with a second piece of copper material; and,
- b. directing a blue laser beam at the work piece, whereby a keyhole mode weld is formed between the first piece of copper based material and the second piece of copper based material; wherein the weld comprises a HAZ
15 and a resolidification zone.

71. The method of claim 70, wherein the laser power is less than 1000 kW.

72. The method of claim 70, wherein the laser power is less than 500 kW.

73. The method of claim 70, wherein the laser power is less than 300 kW.

20 74. The method of claim 70, comprising elongating the laser beam to suppress spatter from the keyhole.

75. The method of claim 70, comprising modulating the laser power to suppress spatter from the keyhole

76. The method of claim 70, comprising rapidly scanning the beam to suppress spatter during the keyhole mode of welding.

77. The method of claim 70, comprising rapidly decreasing the laser power after the weld is initiated, wherein the method of reducing can be automatically or manually.

78. The methods of claims 1, 23, or 70, comprising using a low atmospheric pressure to reduce entrapped gases and spatter during the welding process.

79. The methods of claims 1, 23, or 70, comprising applying a shielding gas.

80. The methods of claims 1, 23, or 70, comprising applying a shielding gas selected from the group consisting of He, Ar, N₂

81. The methods of claims 1, 23, or 70, comprising applying a shielding gas mixture selected from the group consisting of Ar-H₂, N₂, N₂-H₂

82. The methods of claims 1, 23, or 70, comprising applying a shielding gas and adding hydrogen to the shielding gas to remove oxide layers and promote wetting of the weld,

83. The methods of claims 1, 23, or 70, comprising directing a second laser beam to the same area as the laser beam to form the weld.

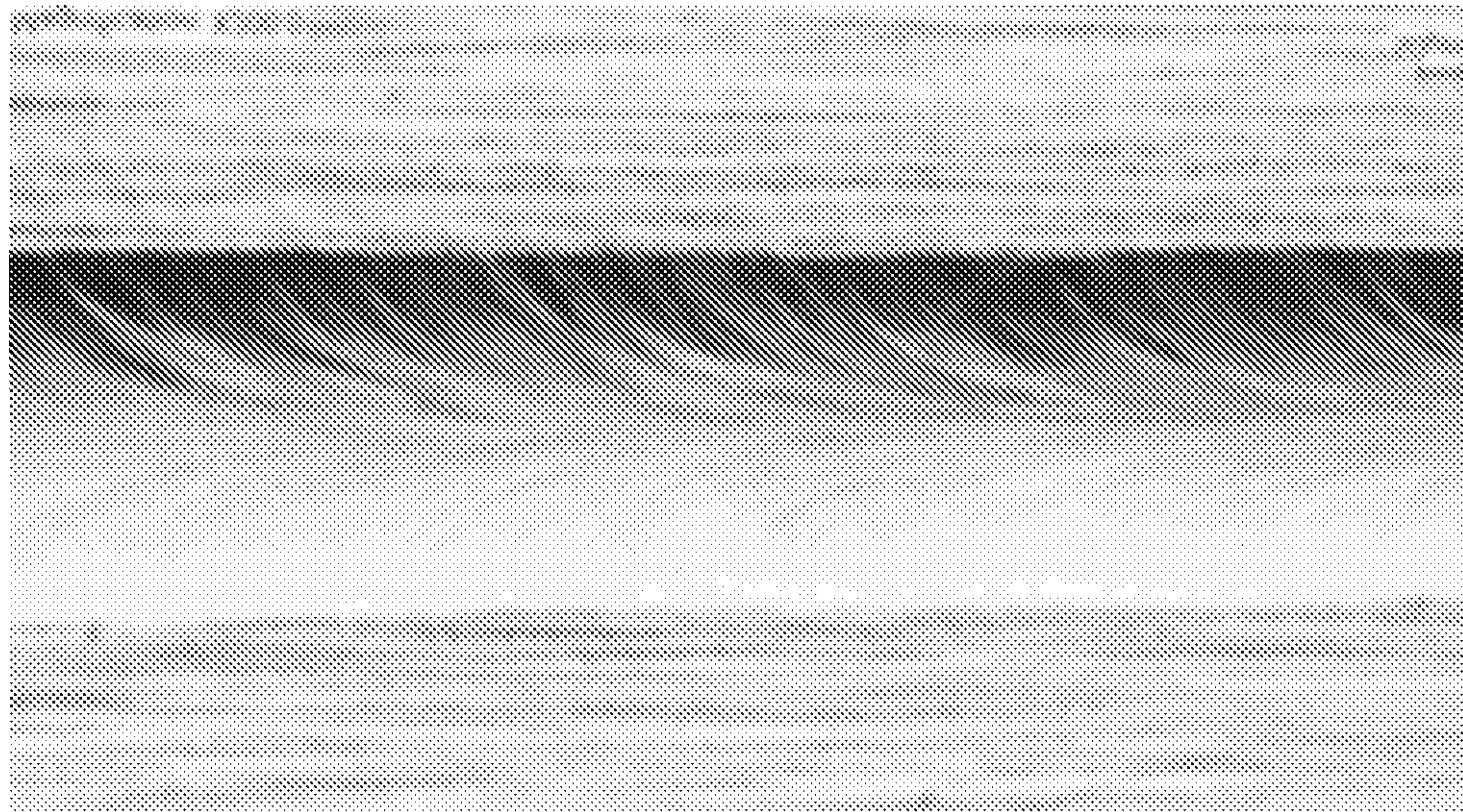


FIG. 1

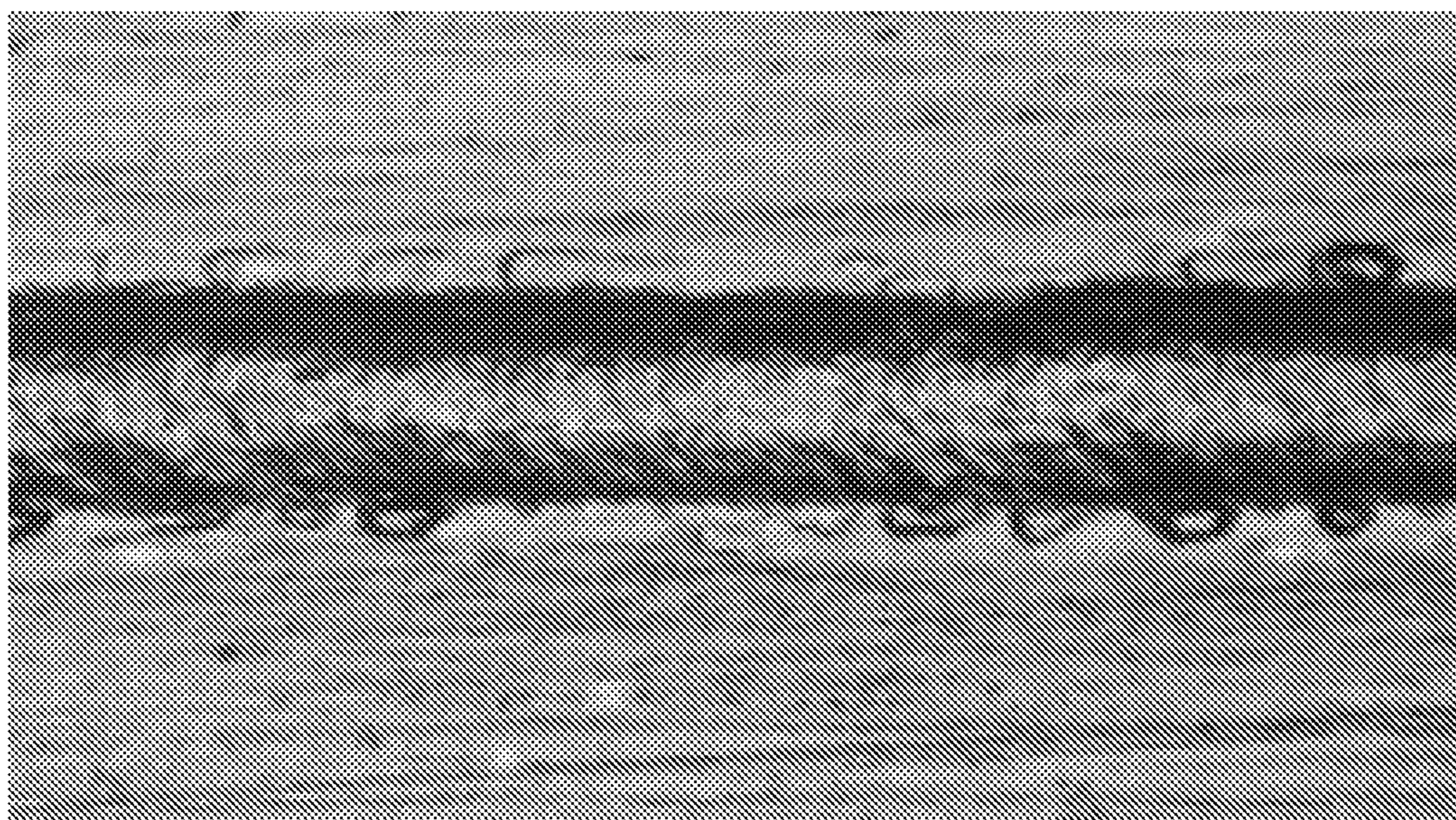


FIG. 2

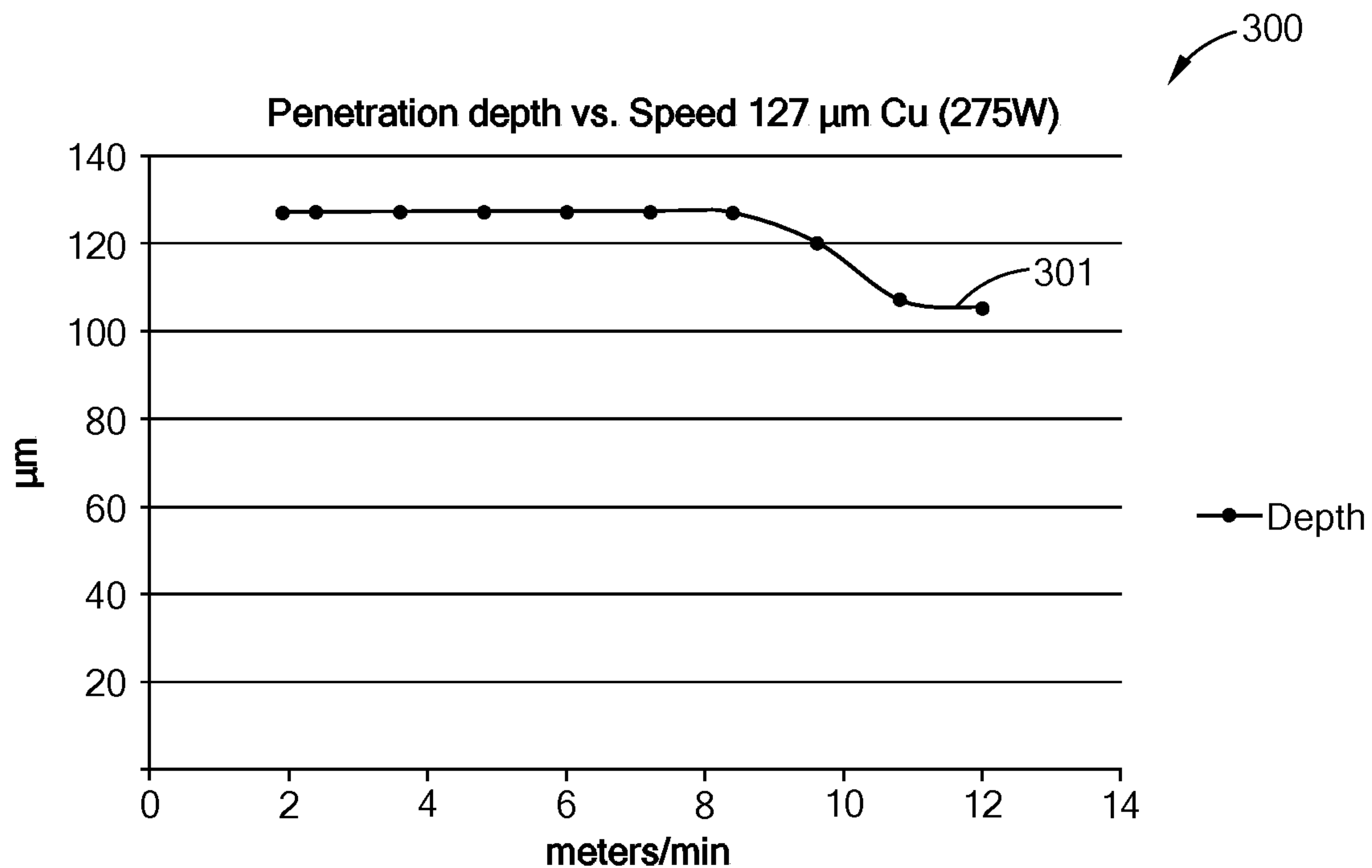


FIG. 3

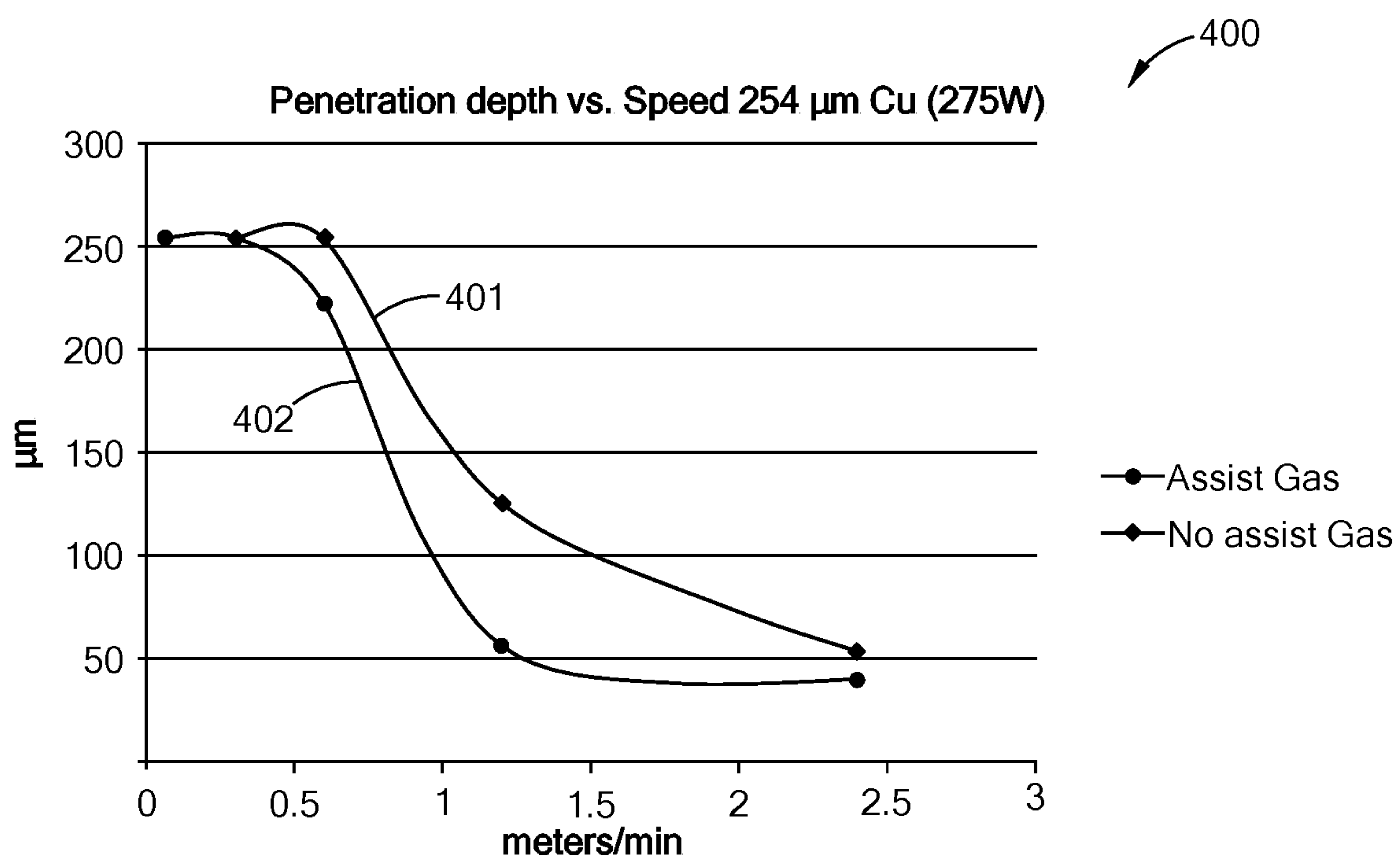


FIG. 4

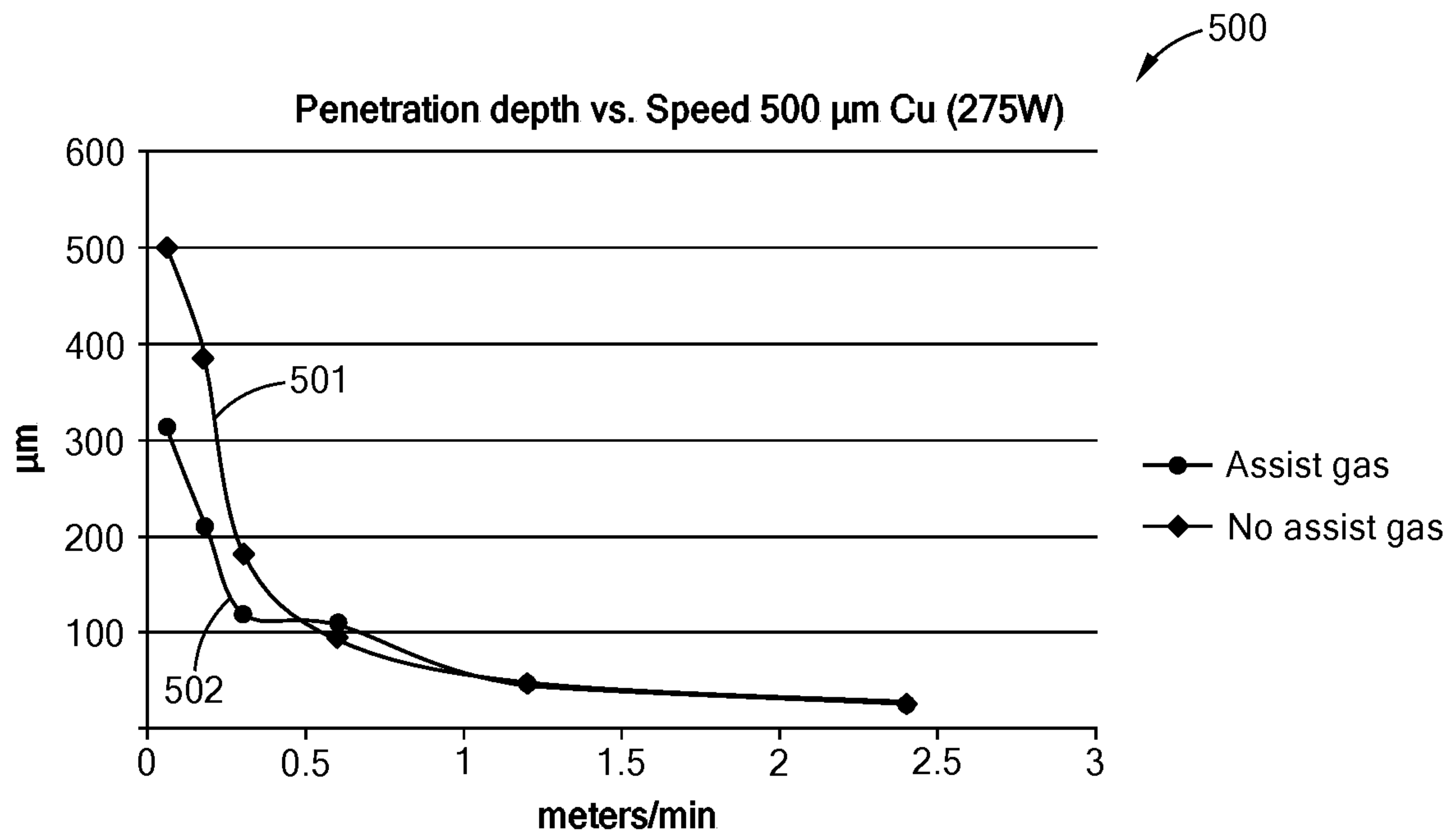


FIG. 5

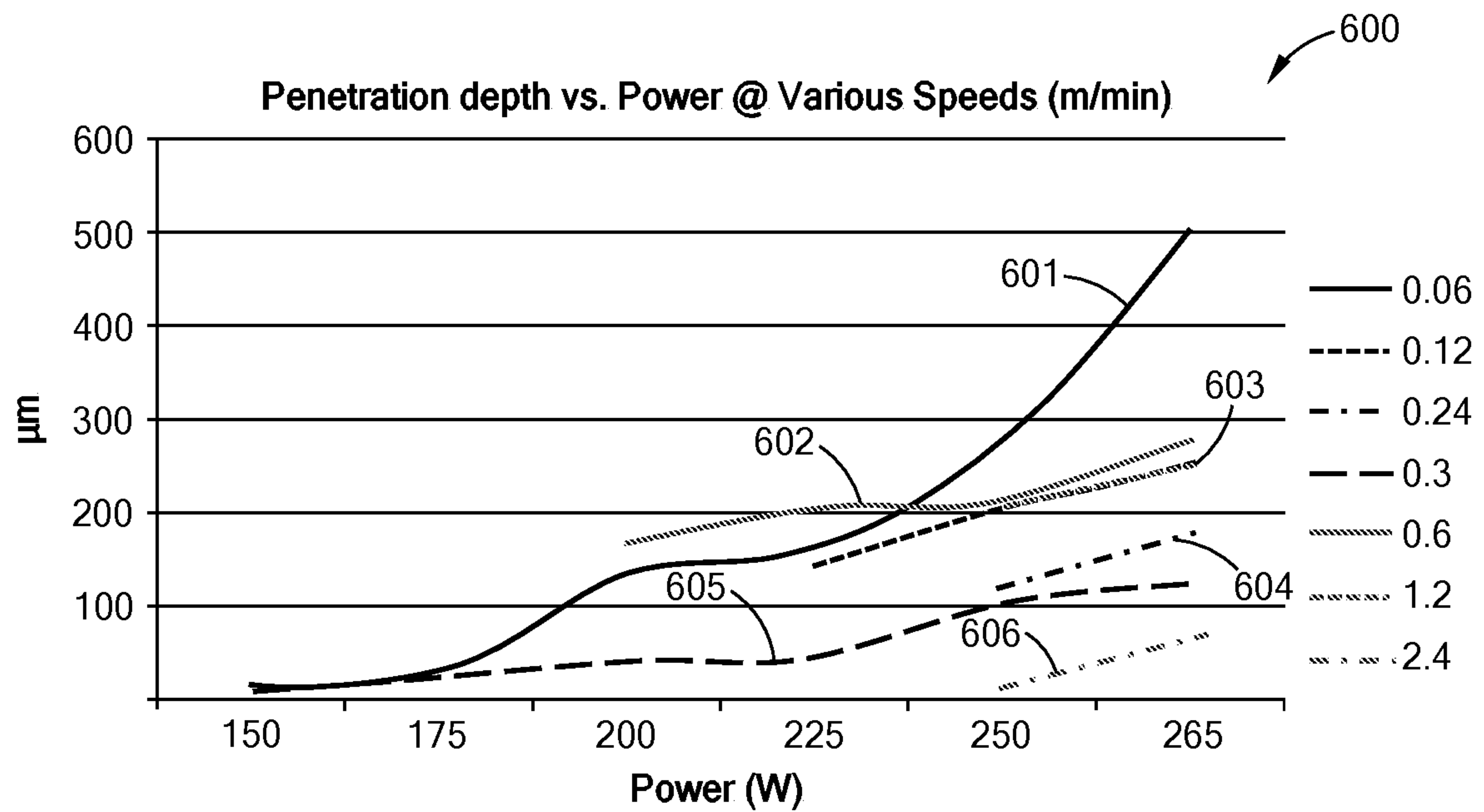


FIG. 6

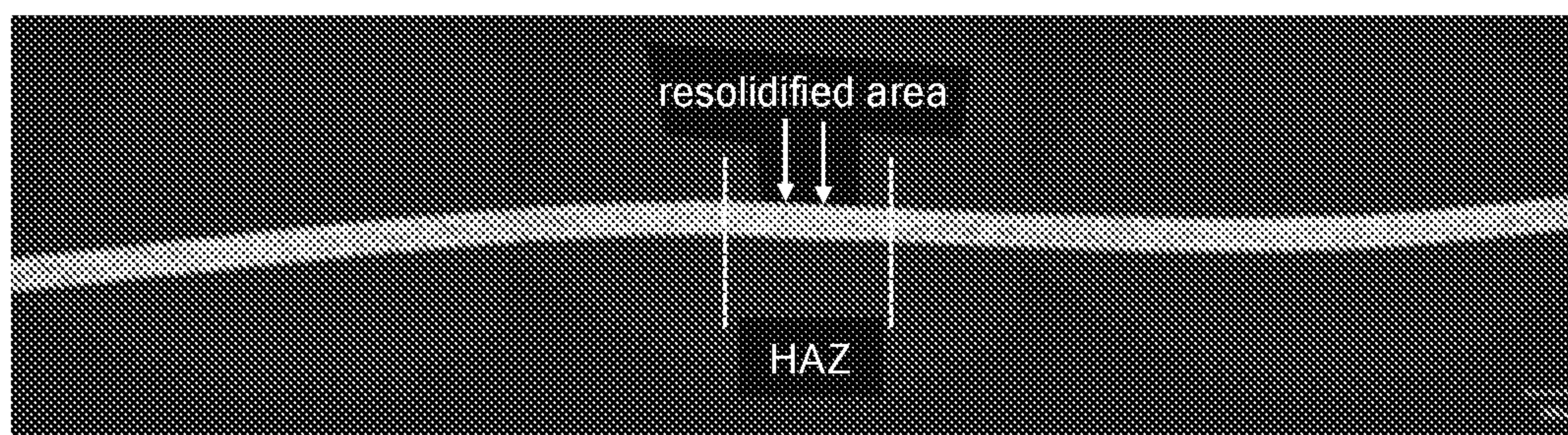


FIG. 7

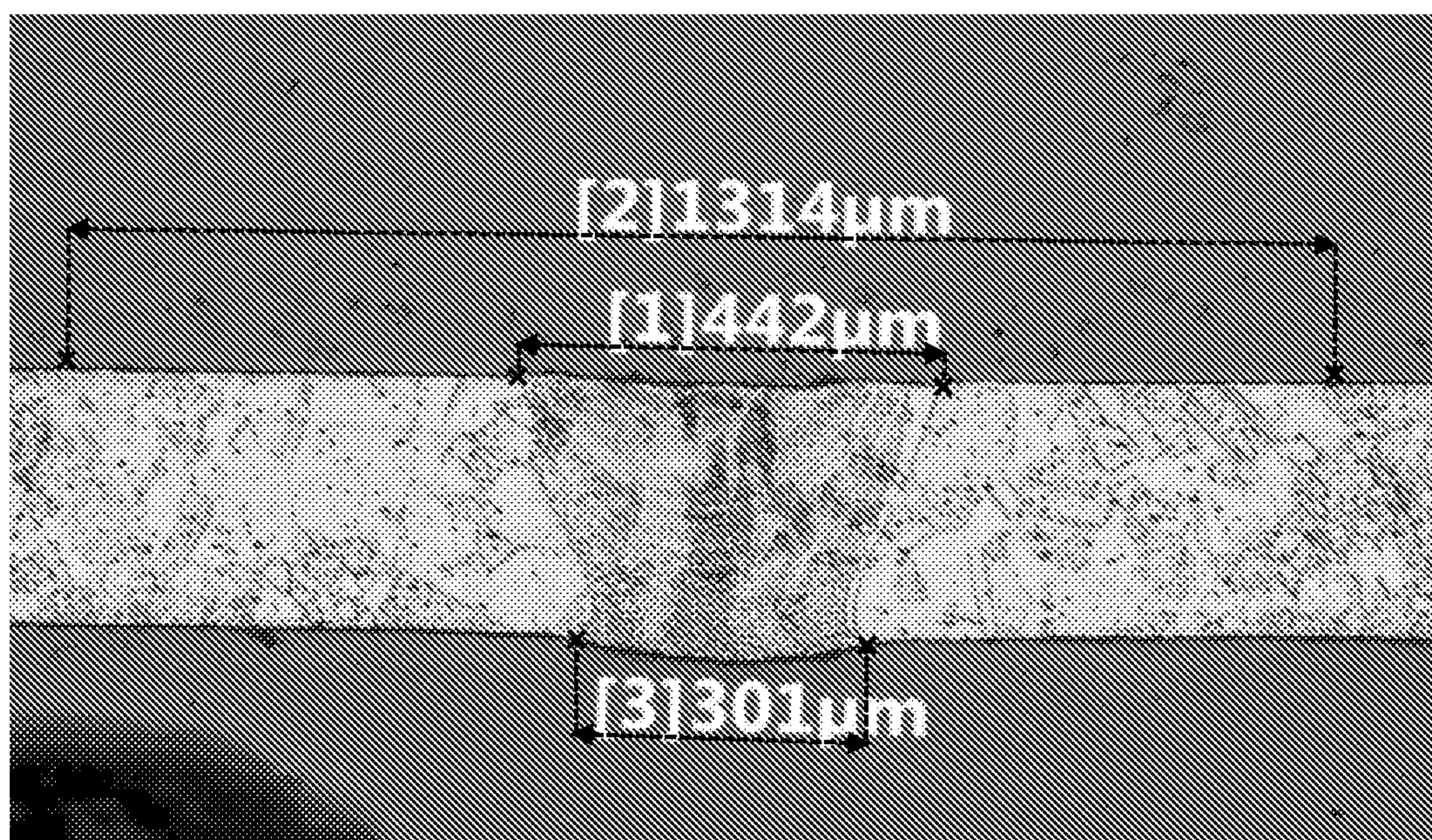


FIG. 8

5 / 11

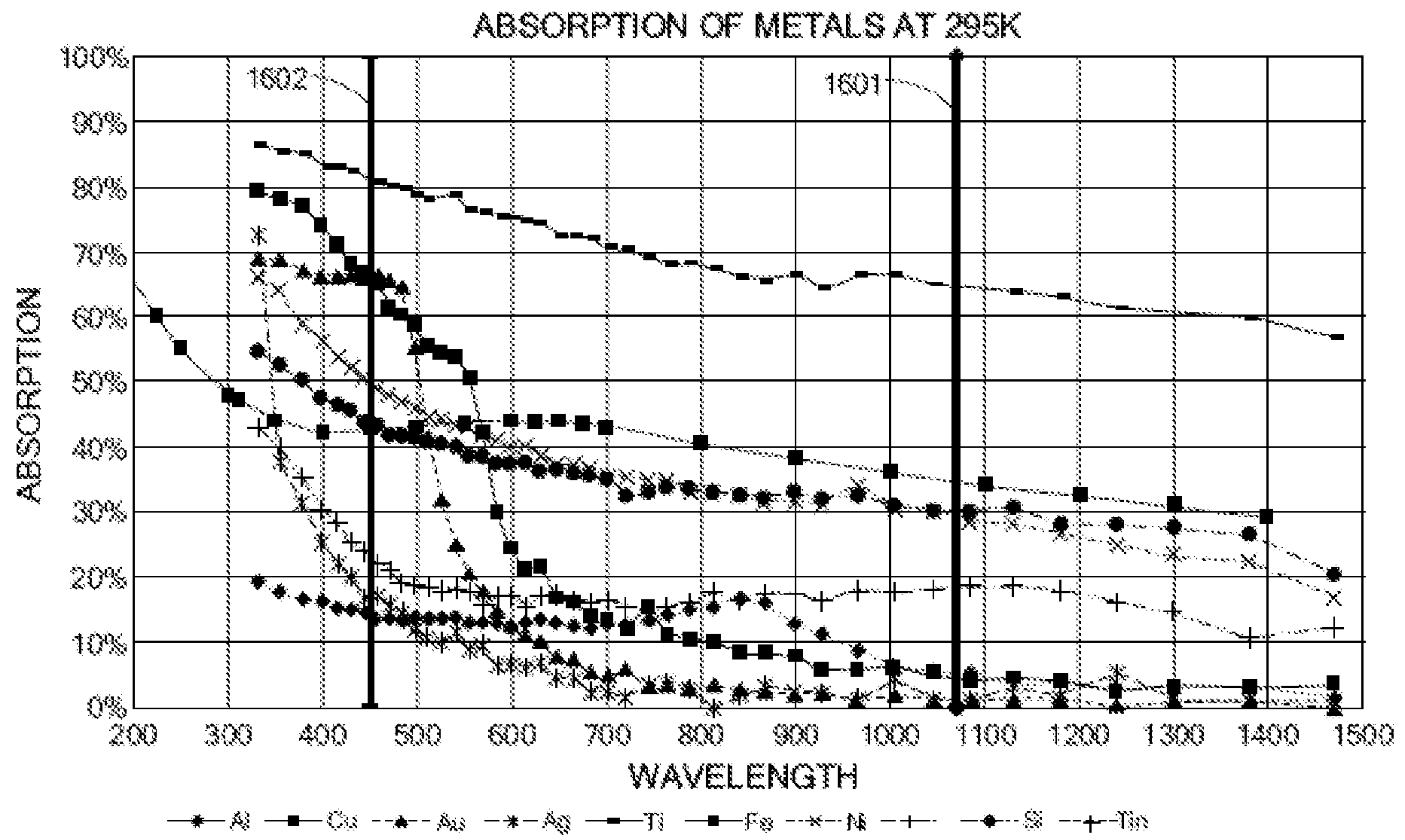


FIG. 9

6 / 11

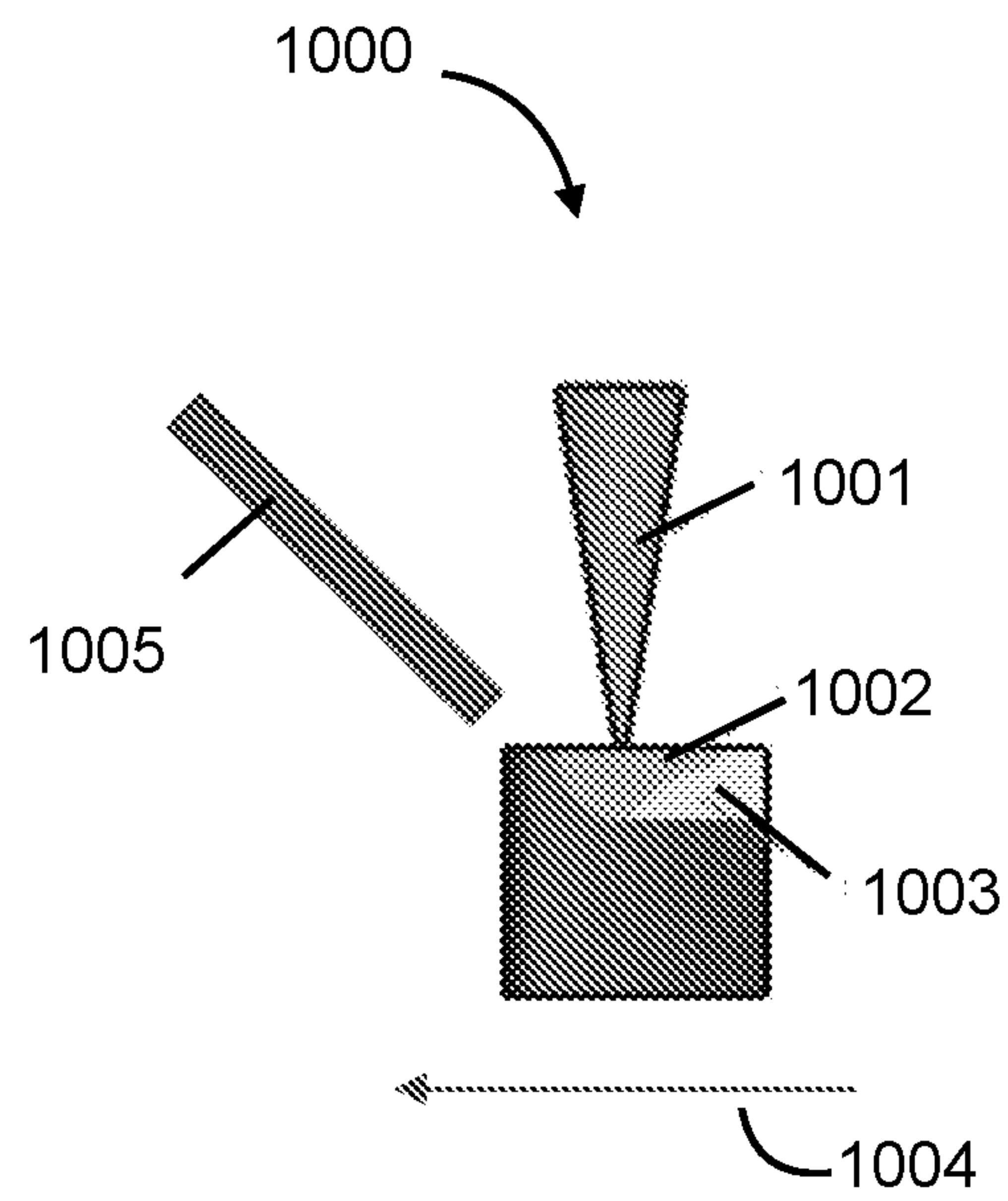


FIG. 10

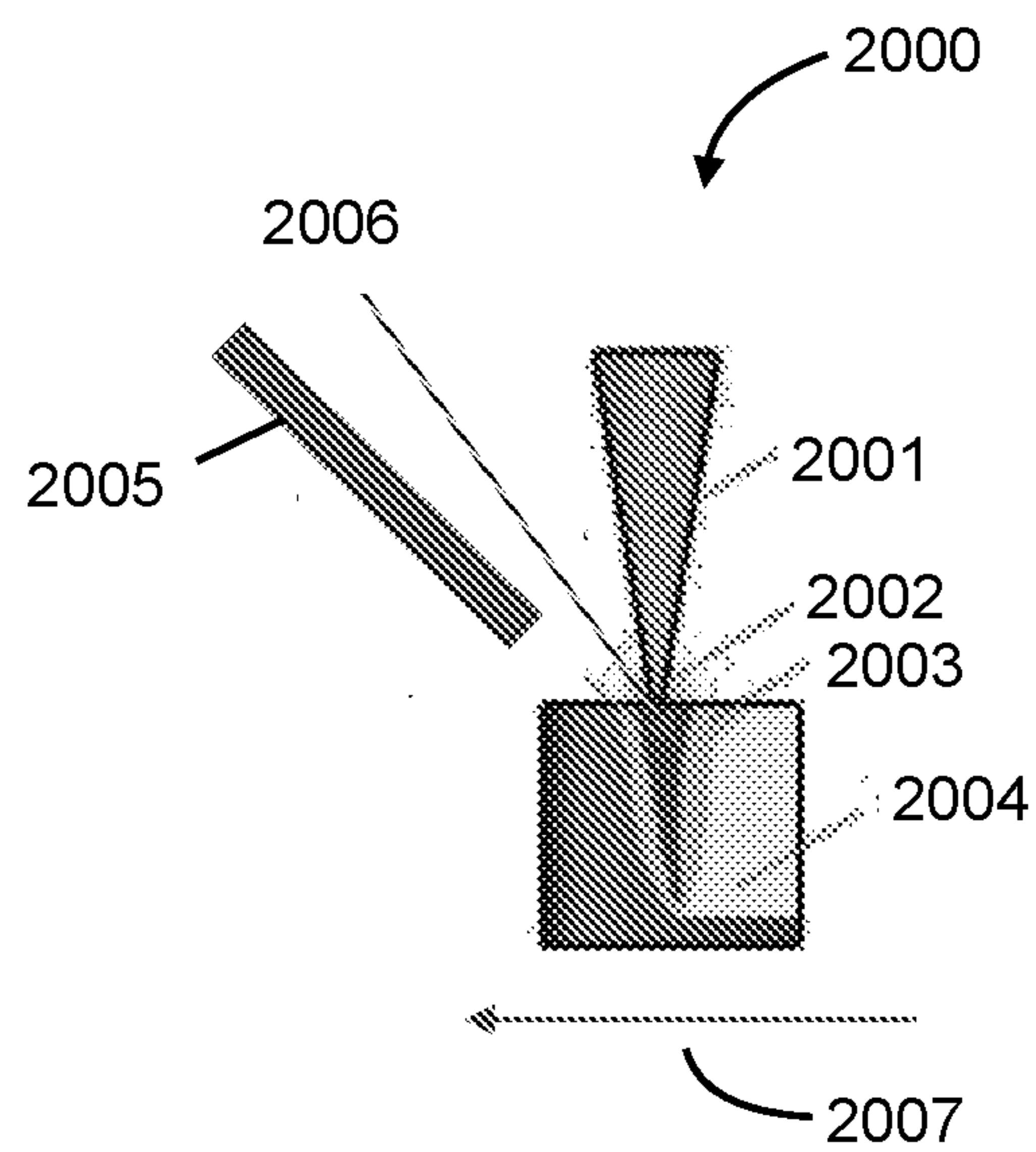


FIG. 11

7 / 11

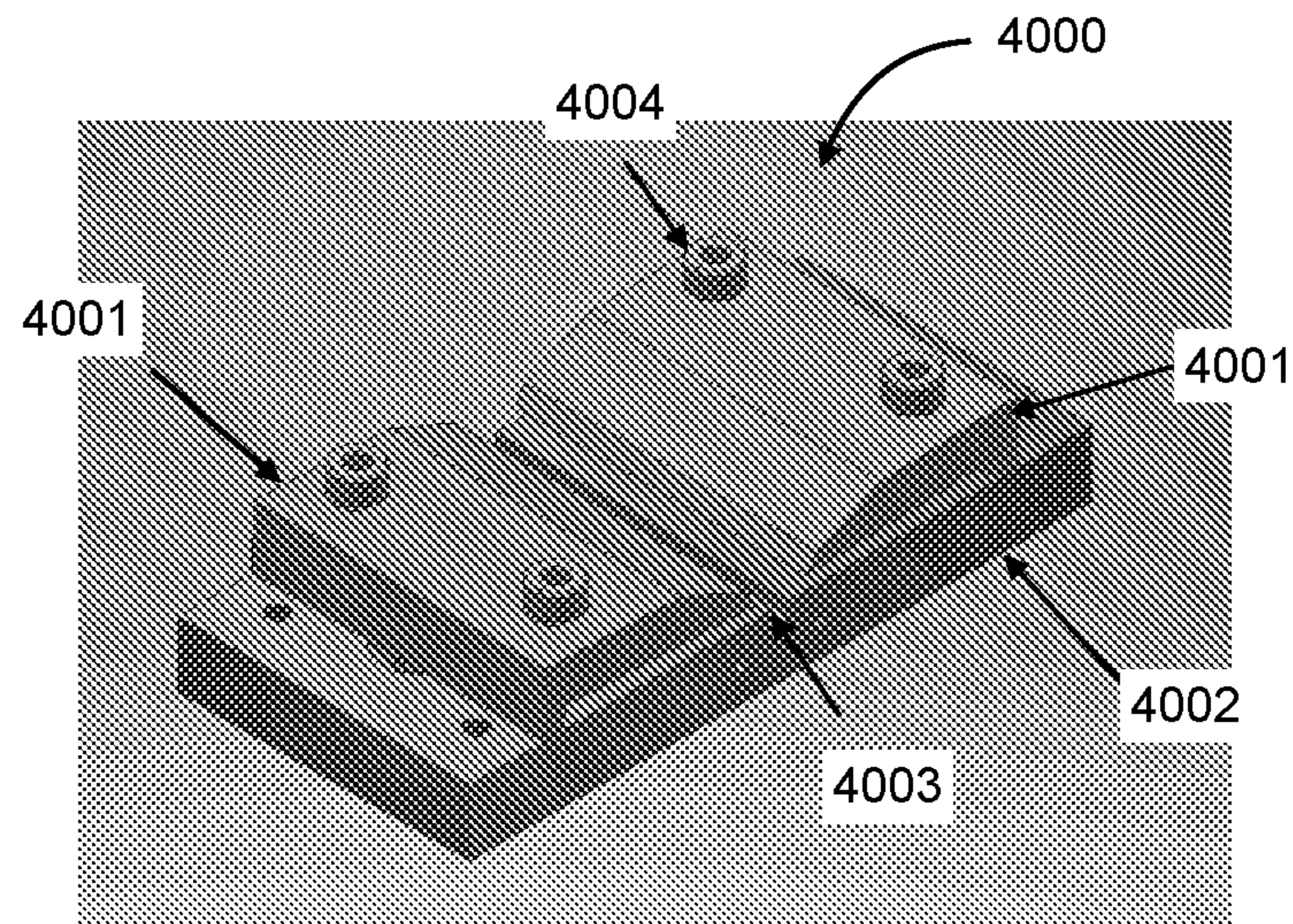


FIG. 12

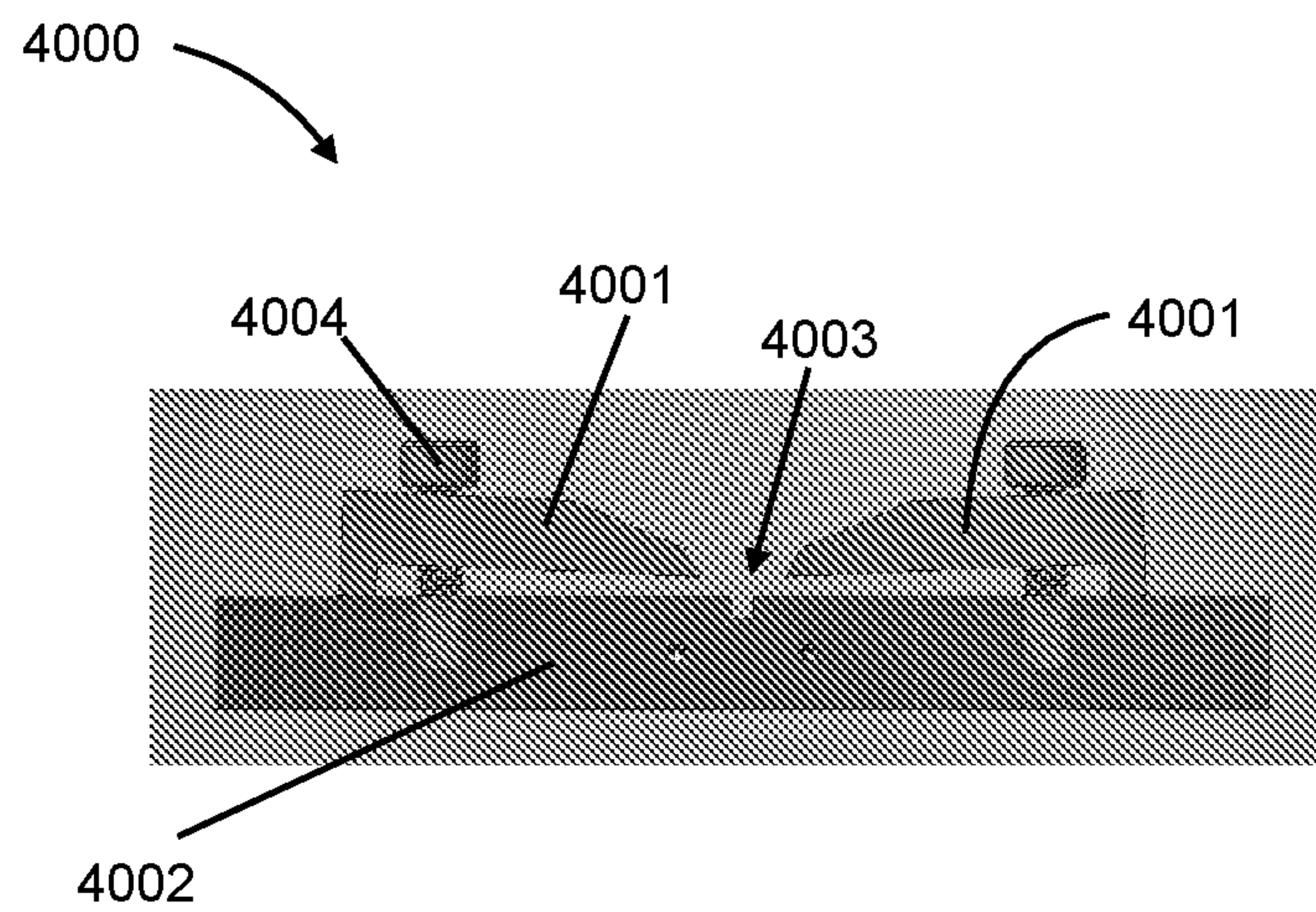


FIG. 12A

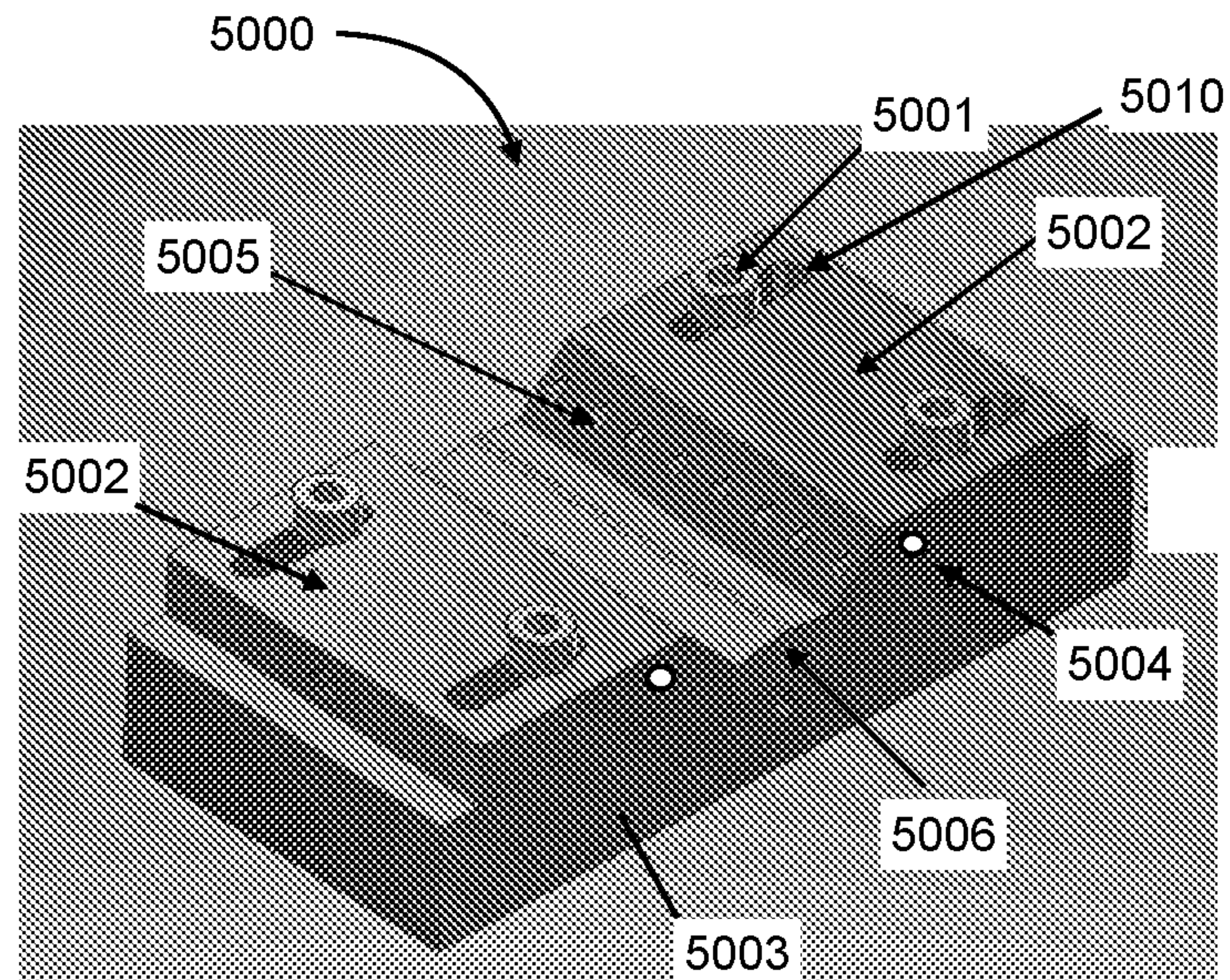


FIG. 13

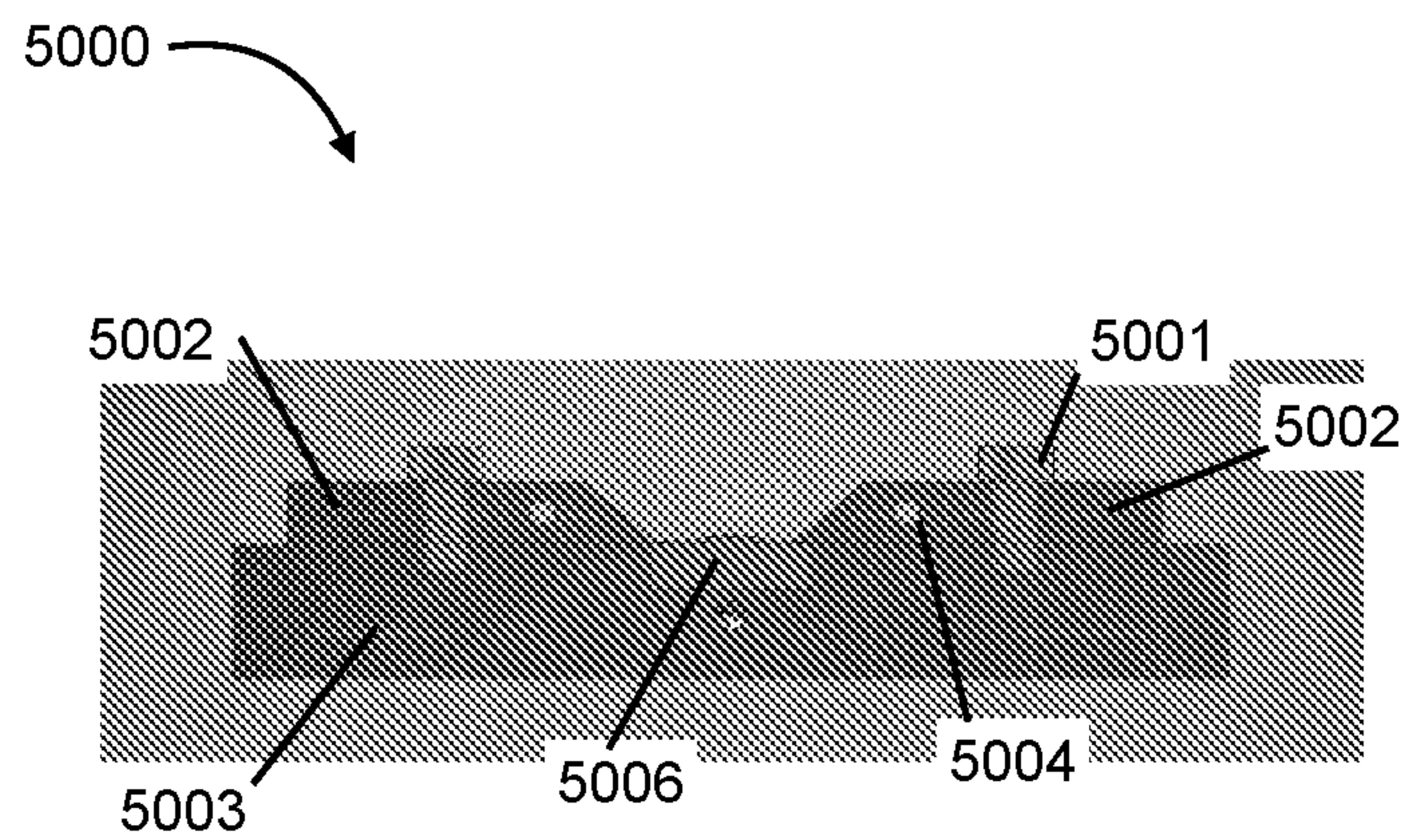


FIG. 13A

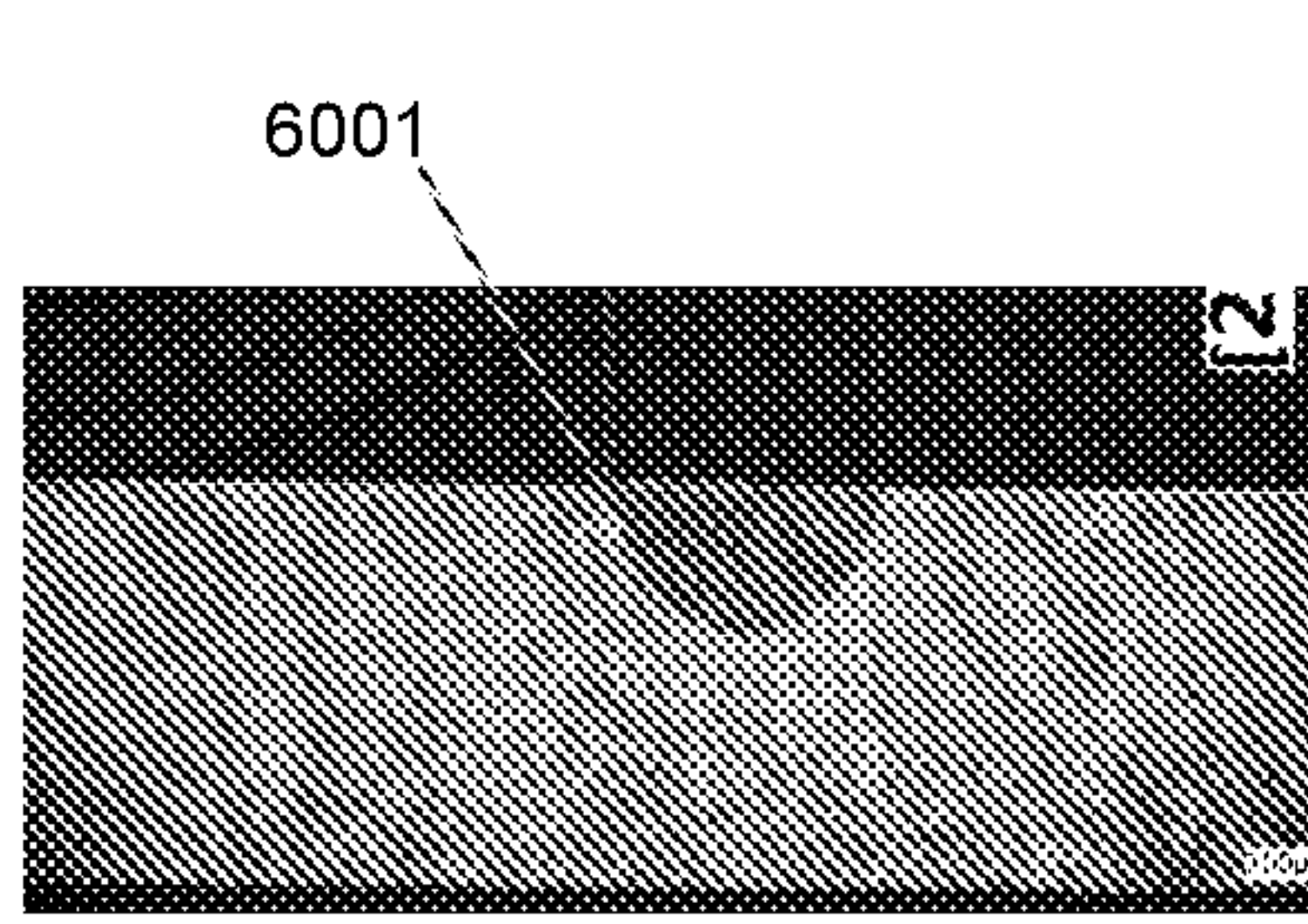


FIG. 14

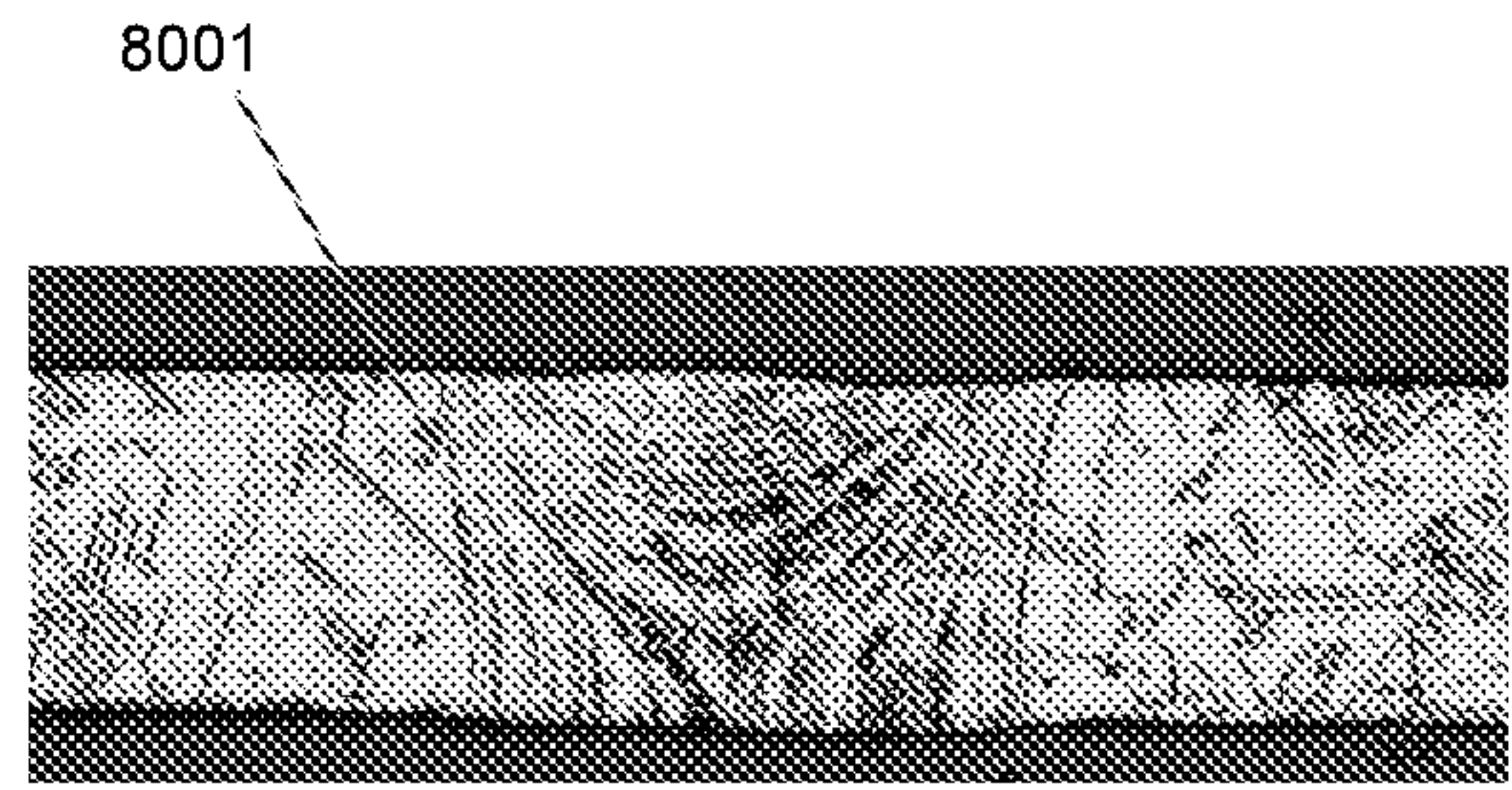


FIG. 16

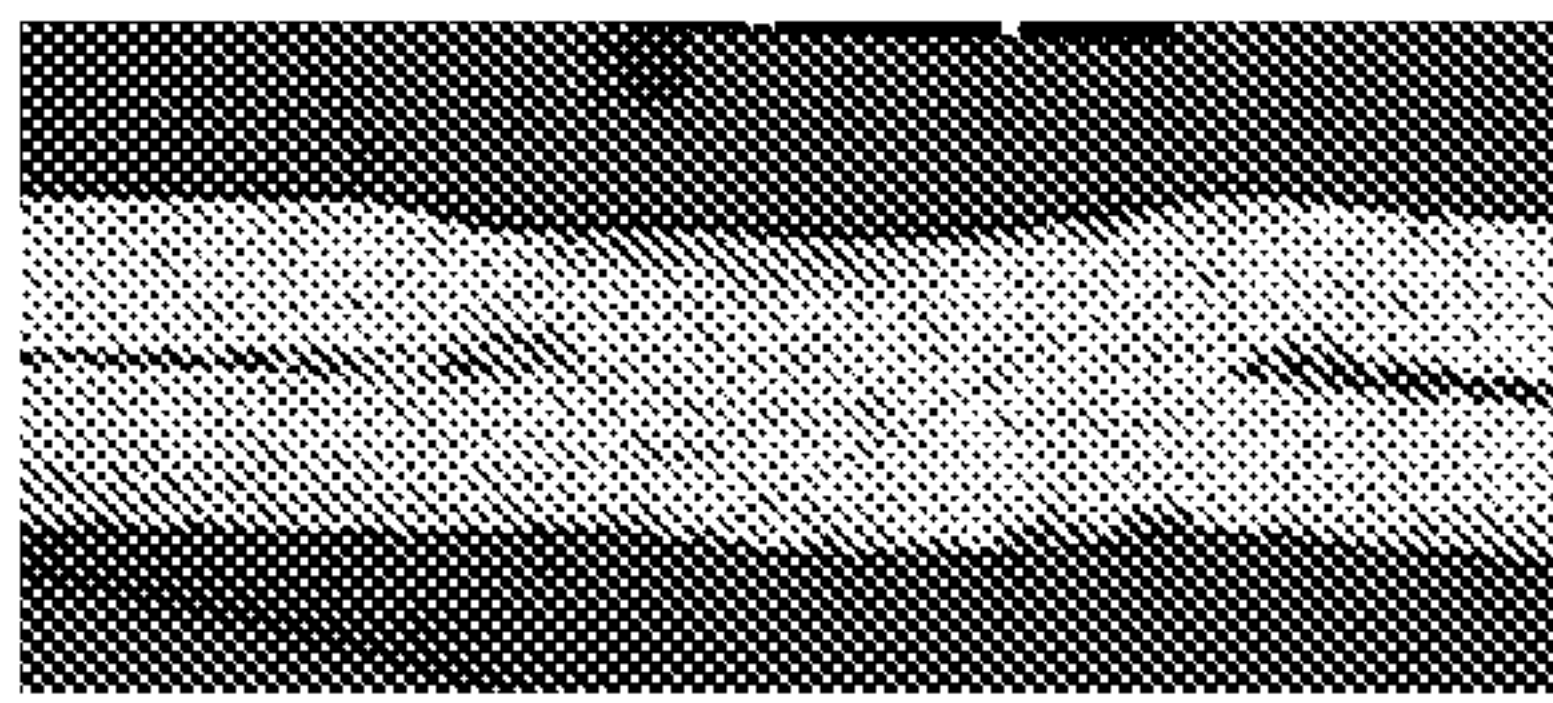


FIG. 15

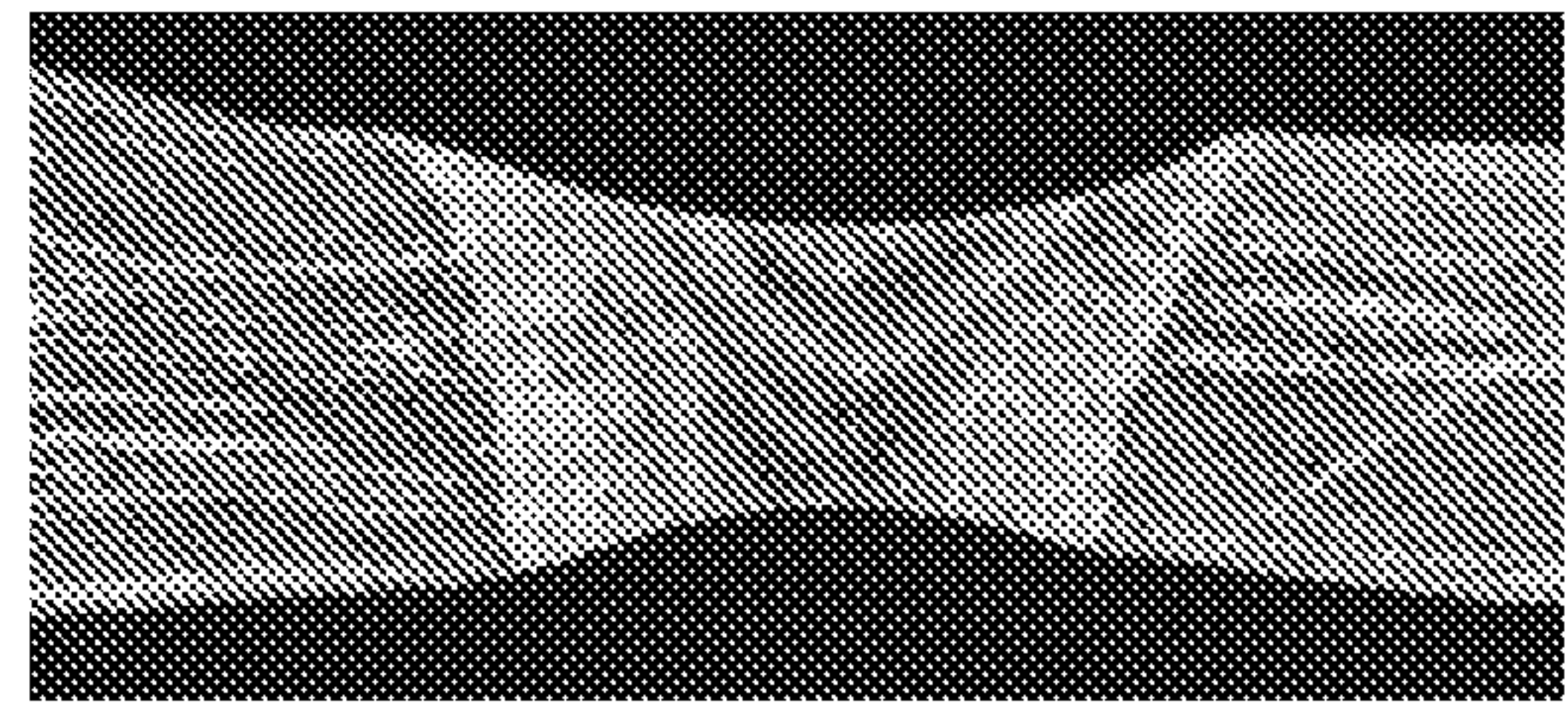


FIG. 17

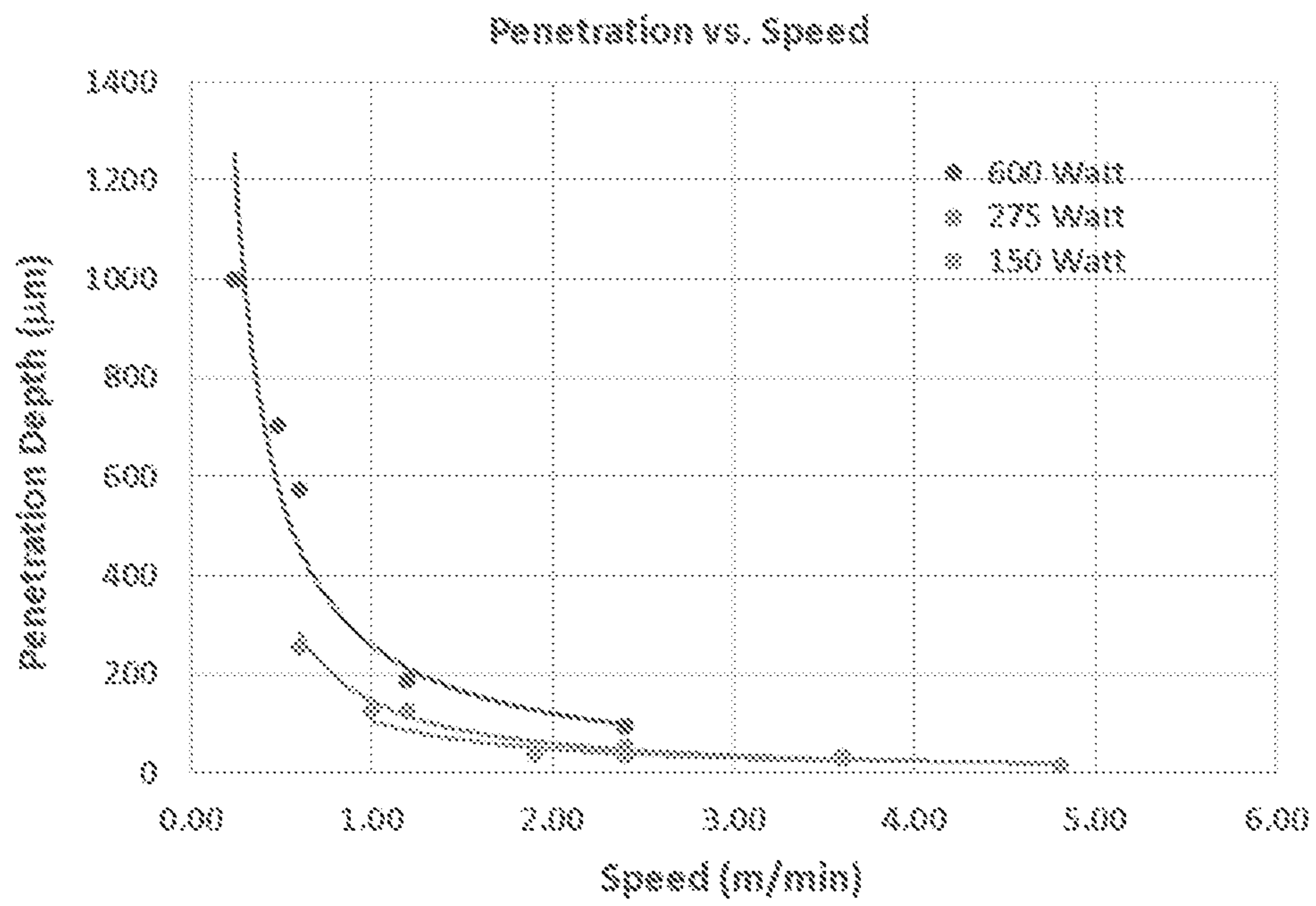


FIG. 18

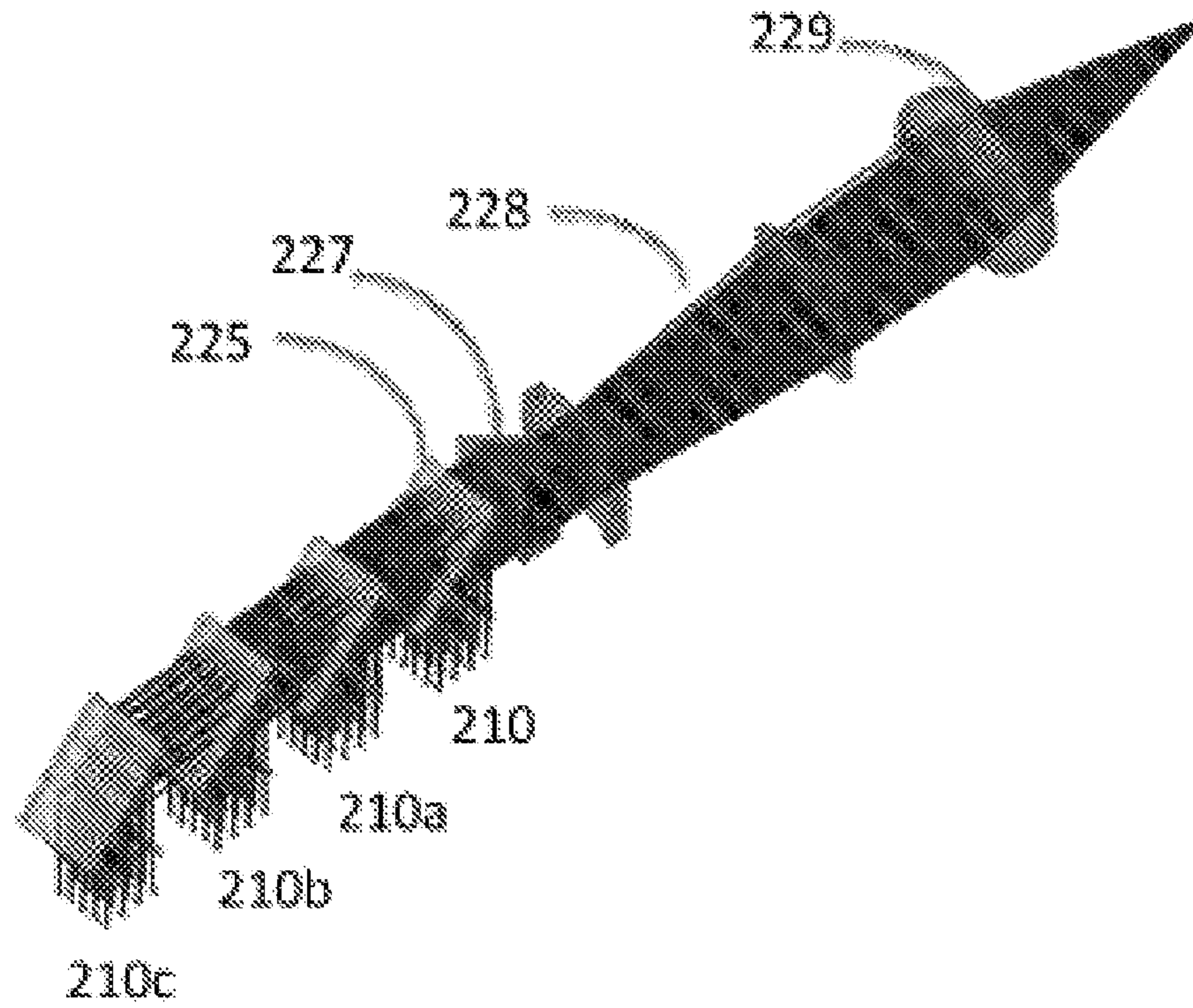


FIG. 19

11 / 11

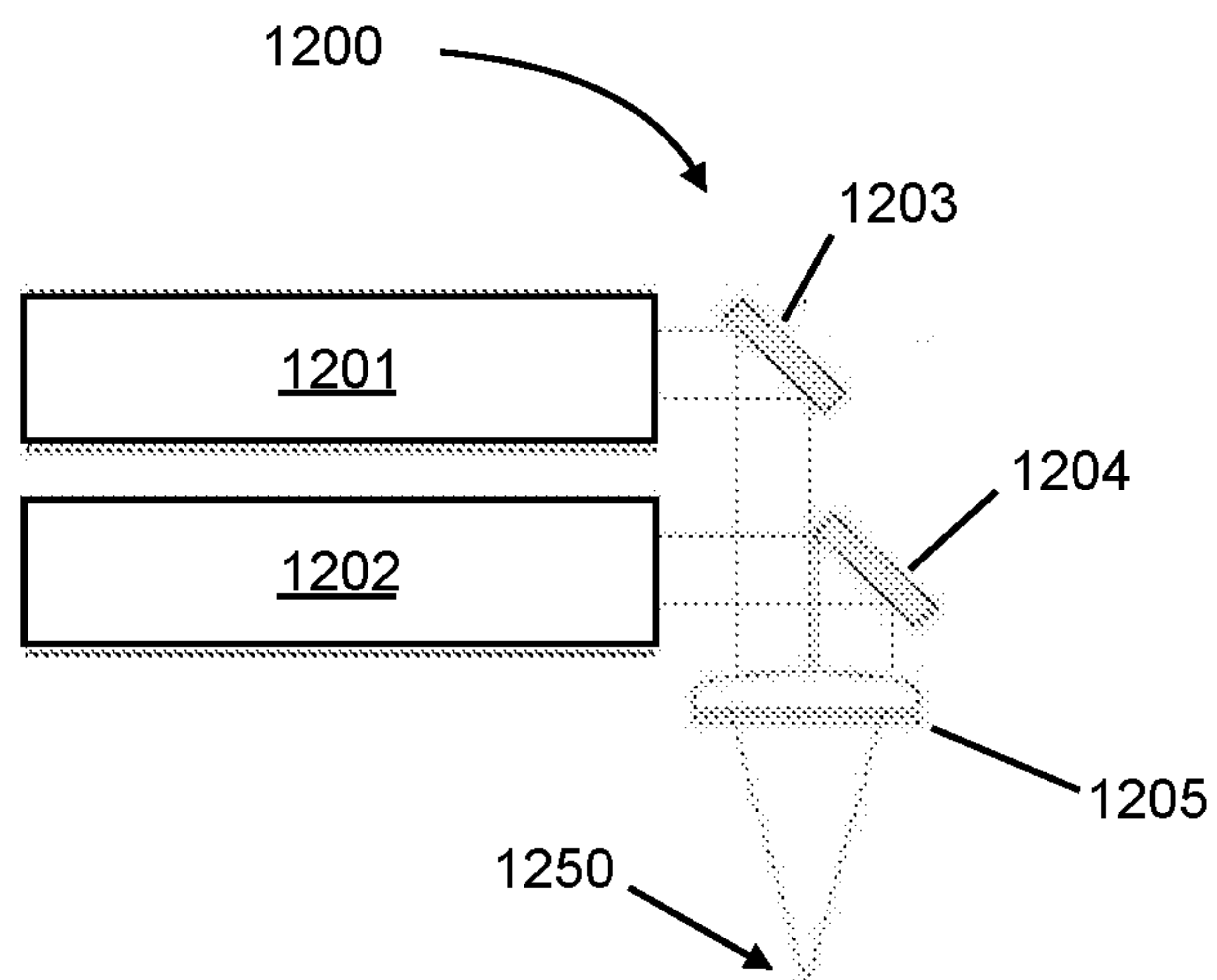


FIG. 20

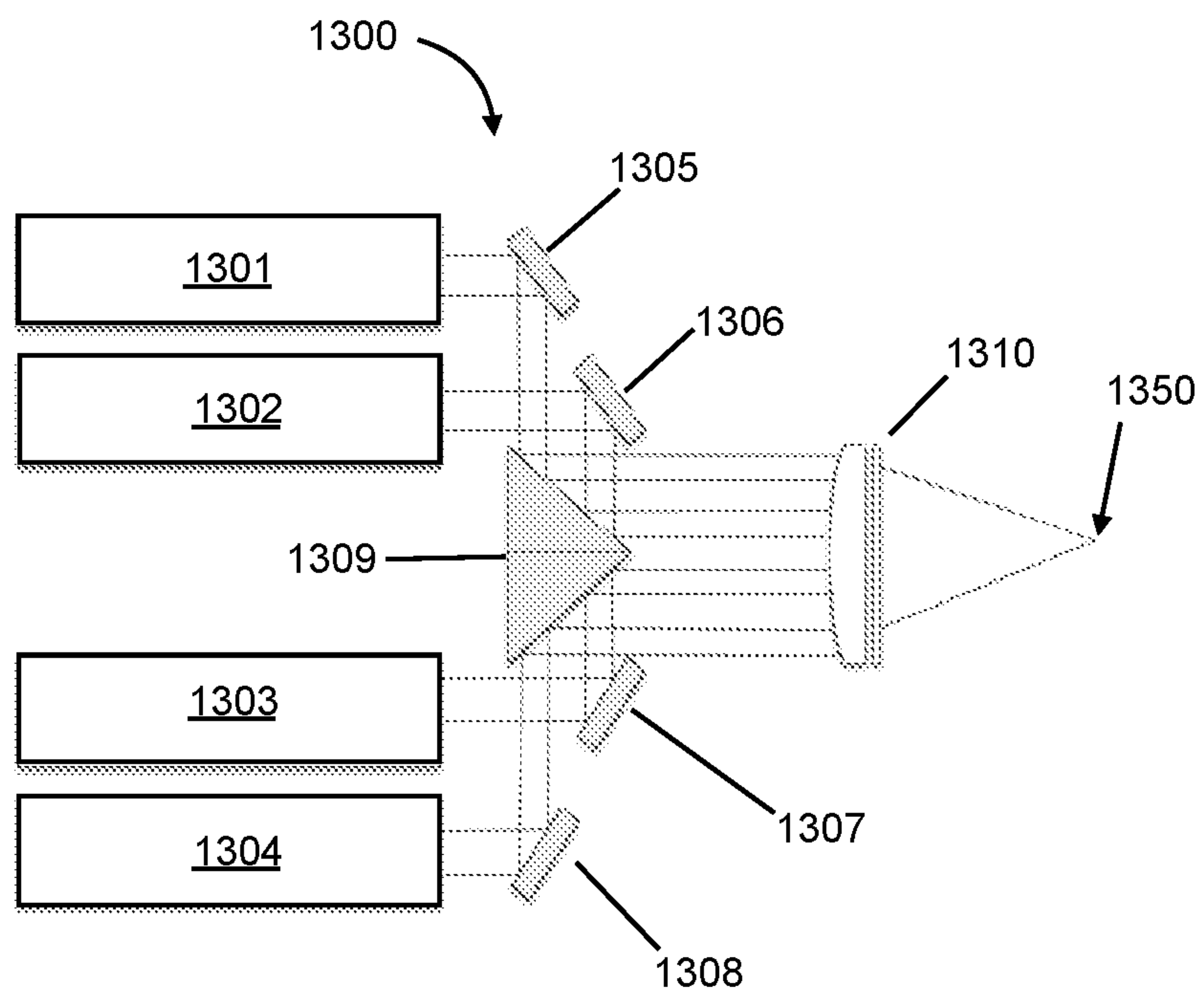


FIG. 21

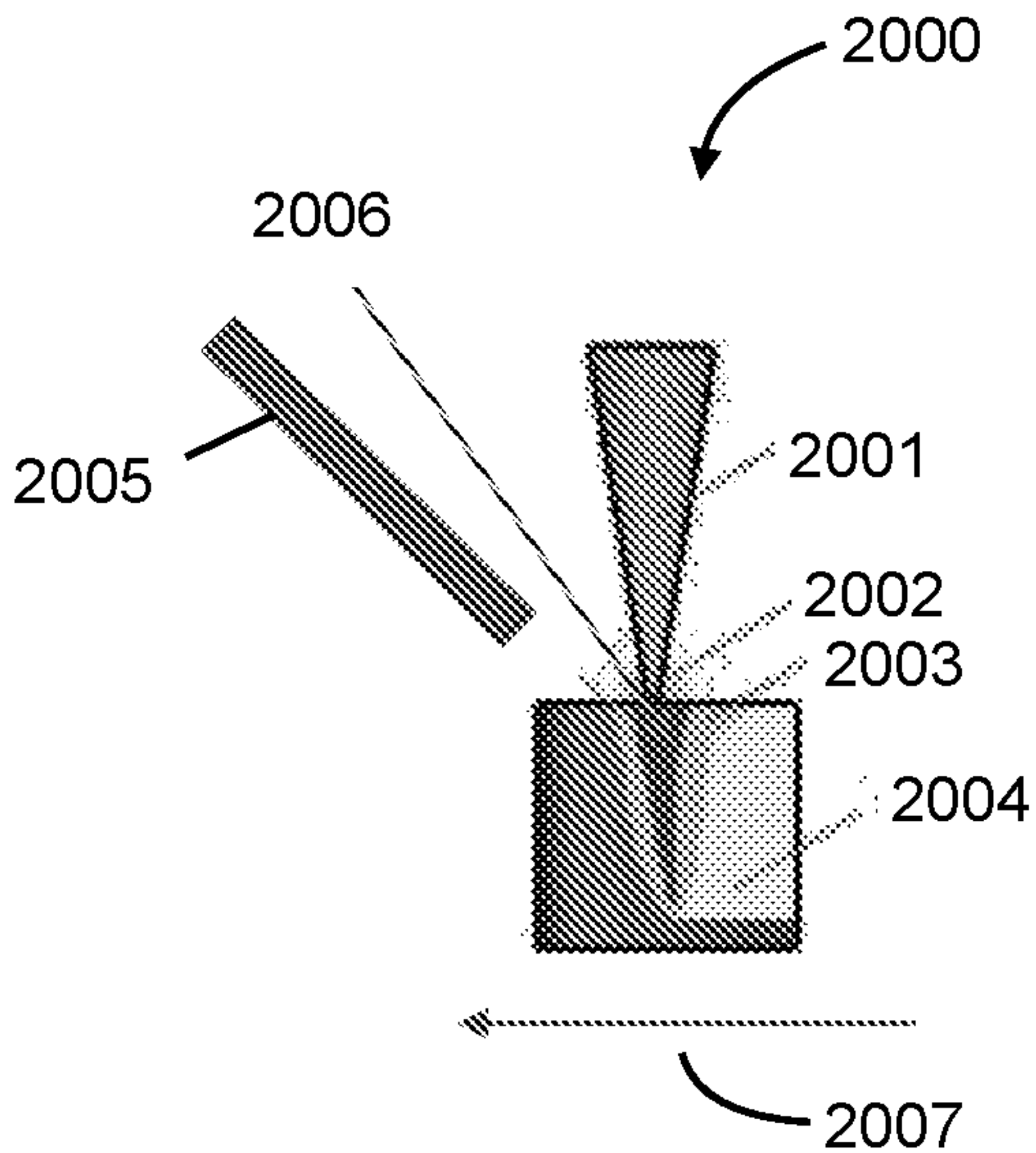


FIG. 11